



# EMI/EMC LF Electromagnetics Overview

- Marius Rosu, PhD
- Lead Product Manager ANSYS Inc.

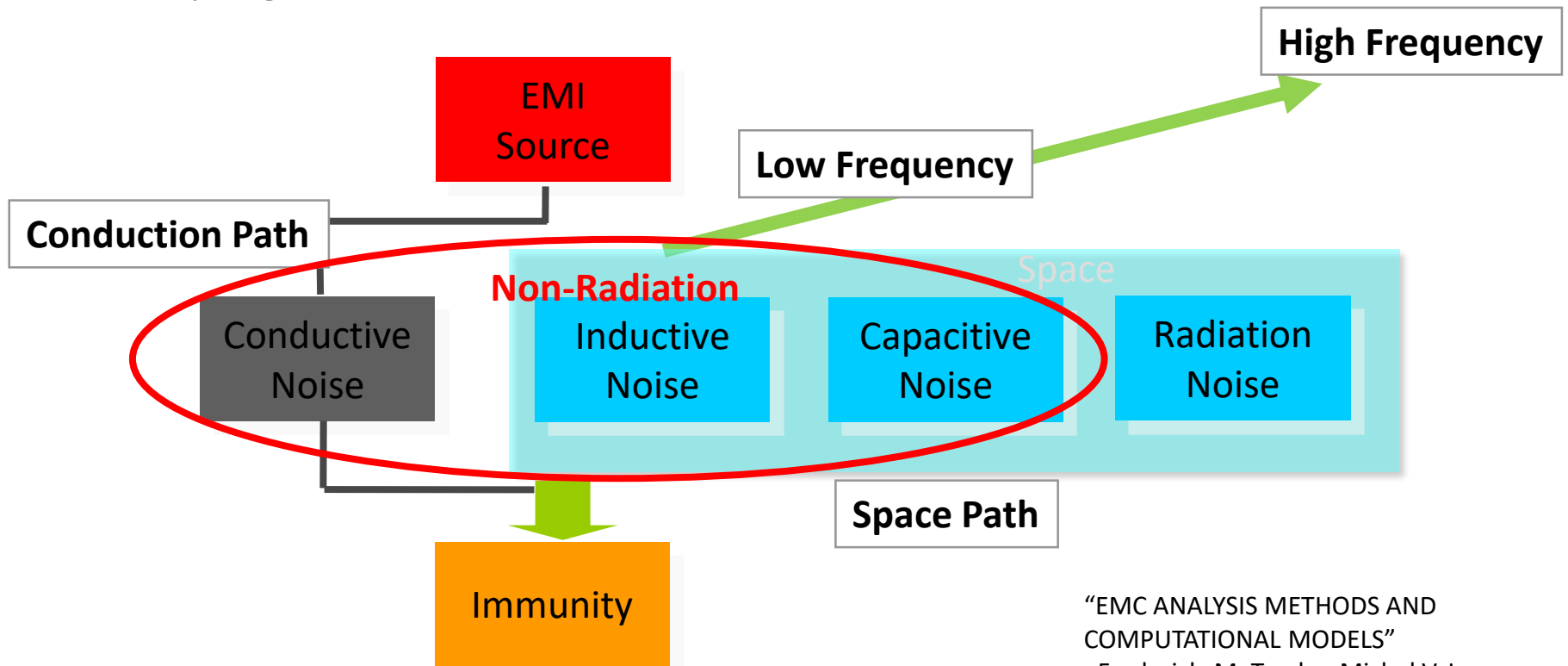


# Agenda

- **EMI - Introduction**
- **Product Description**
- **Conductive Noise Simulation with Power Module and Cable**
- **Low Frequency Signal Integrity**

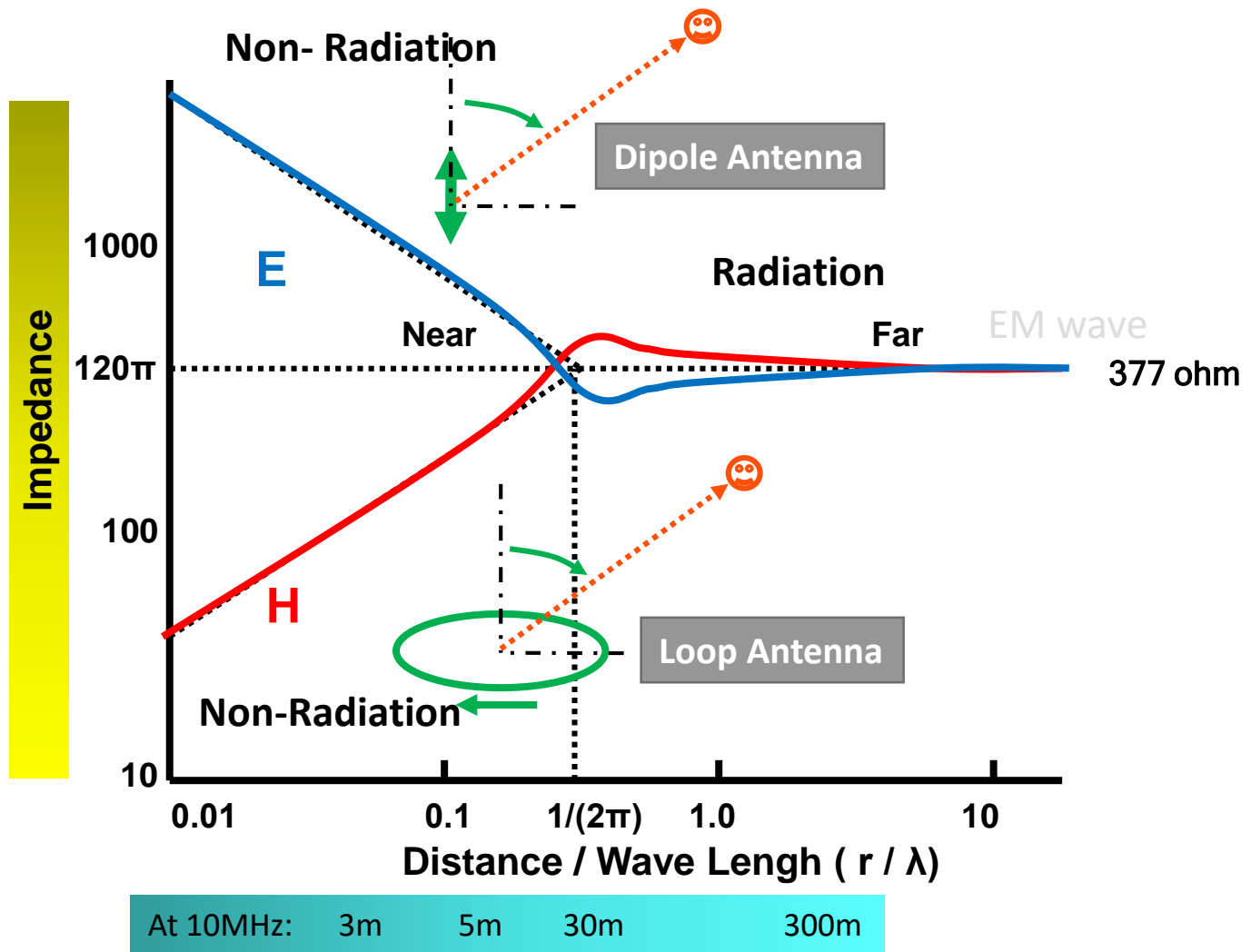
# Three Factors – EM Noise Issue

- 1) Noise Source(EMI)
- 2) Load (Immunity)
- 3) Coupling Path



“EMC ANALYSIS METHODS AND  
COMPUTATIONAL MODELS”  
: Frederick M. Tesche, Michel V. Ianoz  
:John Wiley & Sons, Inc. 1997 p34-36

# Noise Source / Electromagnetics Space Size

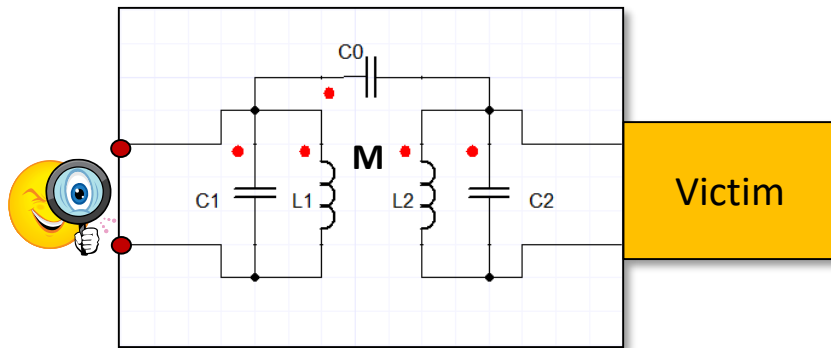
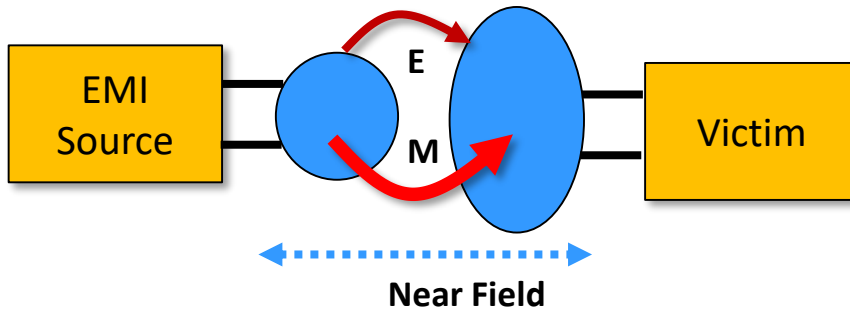


Tokyo Denki University Publication Bureau of the high frequency electromagnetic

# Equivalent Circuit of Near Field Coupling

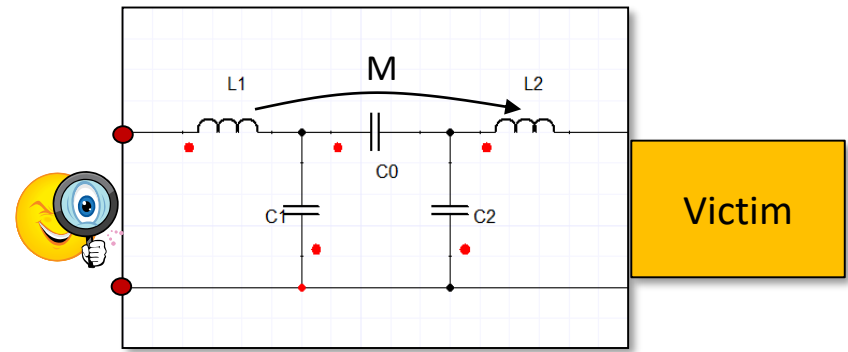
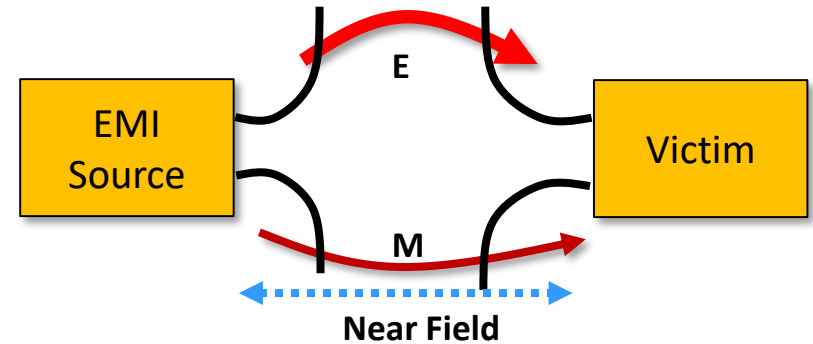
## Inductive Noise

Source-Victim Coupling by Magnetic Field



## Capacitive Noise

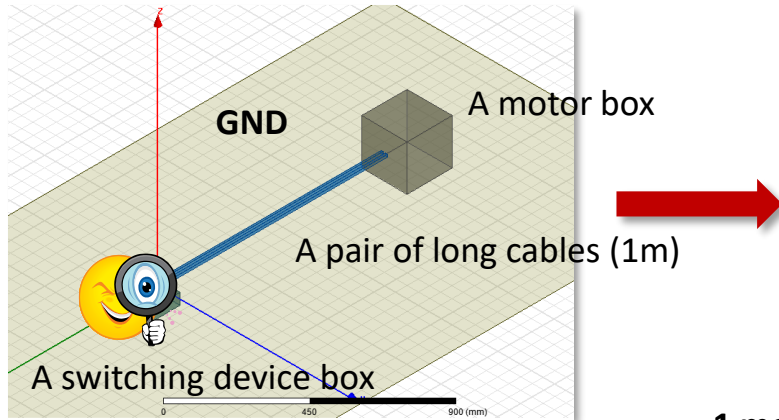
Source-Victim Coupling by E-Field



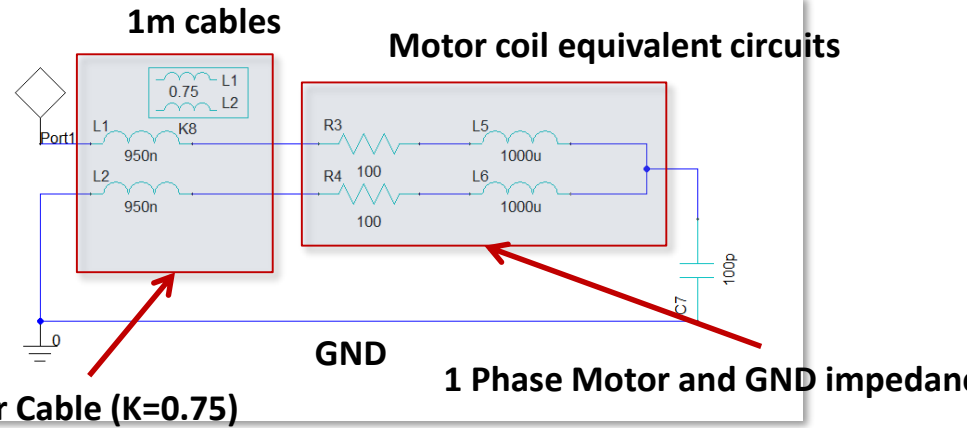
“EMC ANALYSIS METHODS AND COMPUTATIONAL MODELS”

: Frederick M. Tesche, Michel V. Ianoz: John Wiley & Sons, Inc.1997 p72-p86

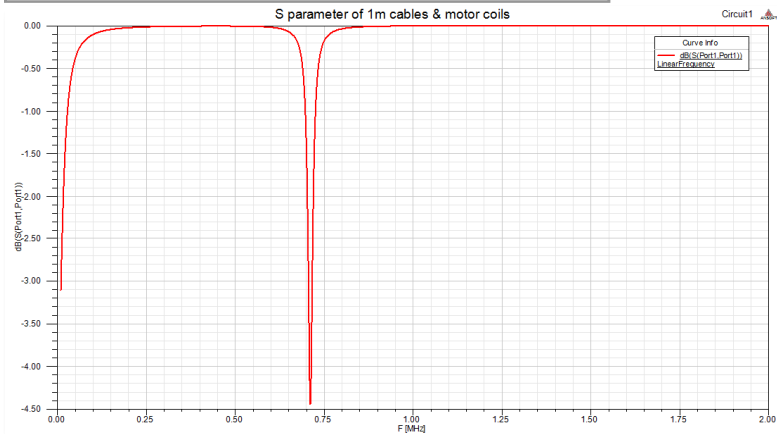
# Equivalent Circuit for Conductive Noise



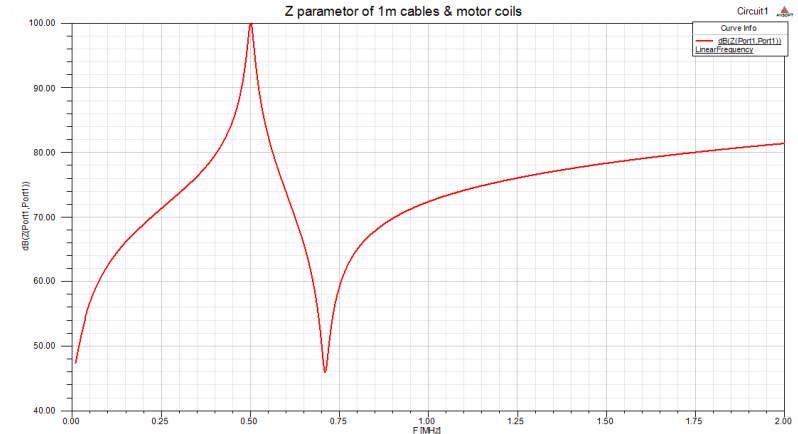
A model of motor and 1 meter cable



1 meter Cable (K=0.75)



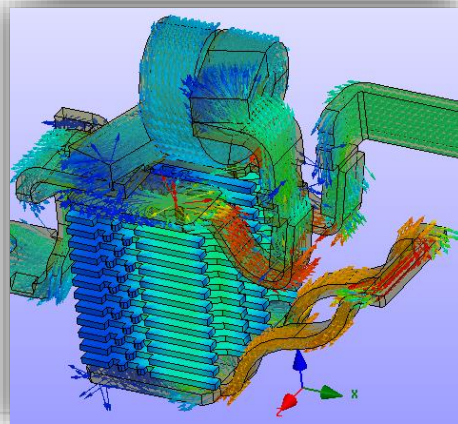
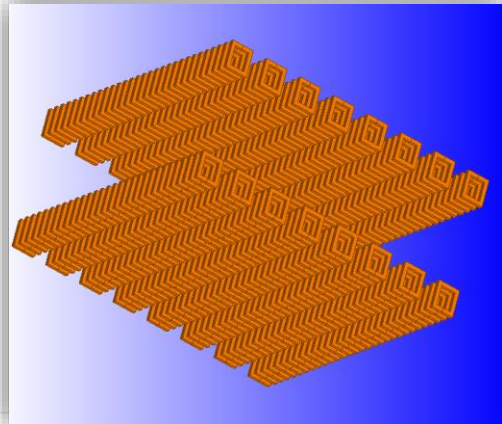
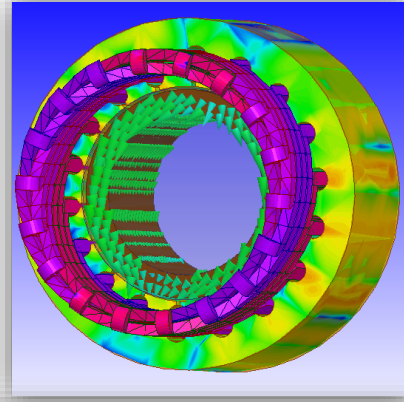
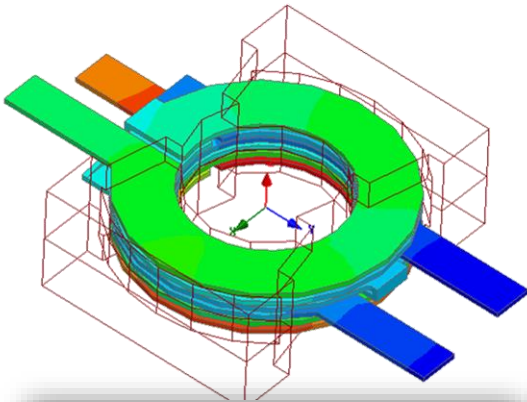
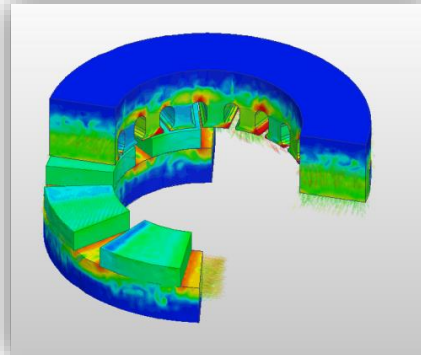
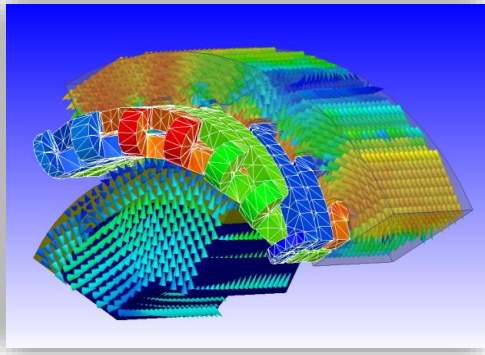
S-parameter (S11)



Z-parameter (Z11)

Traveling currents and voltages in a transmission line are affected when they meet a discontinuity caused by the insertion of a network into the transmission line. This is equivalent to the wave meeting an impedance differing from the line's characteristic impedance

# ANSYS Maxwell



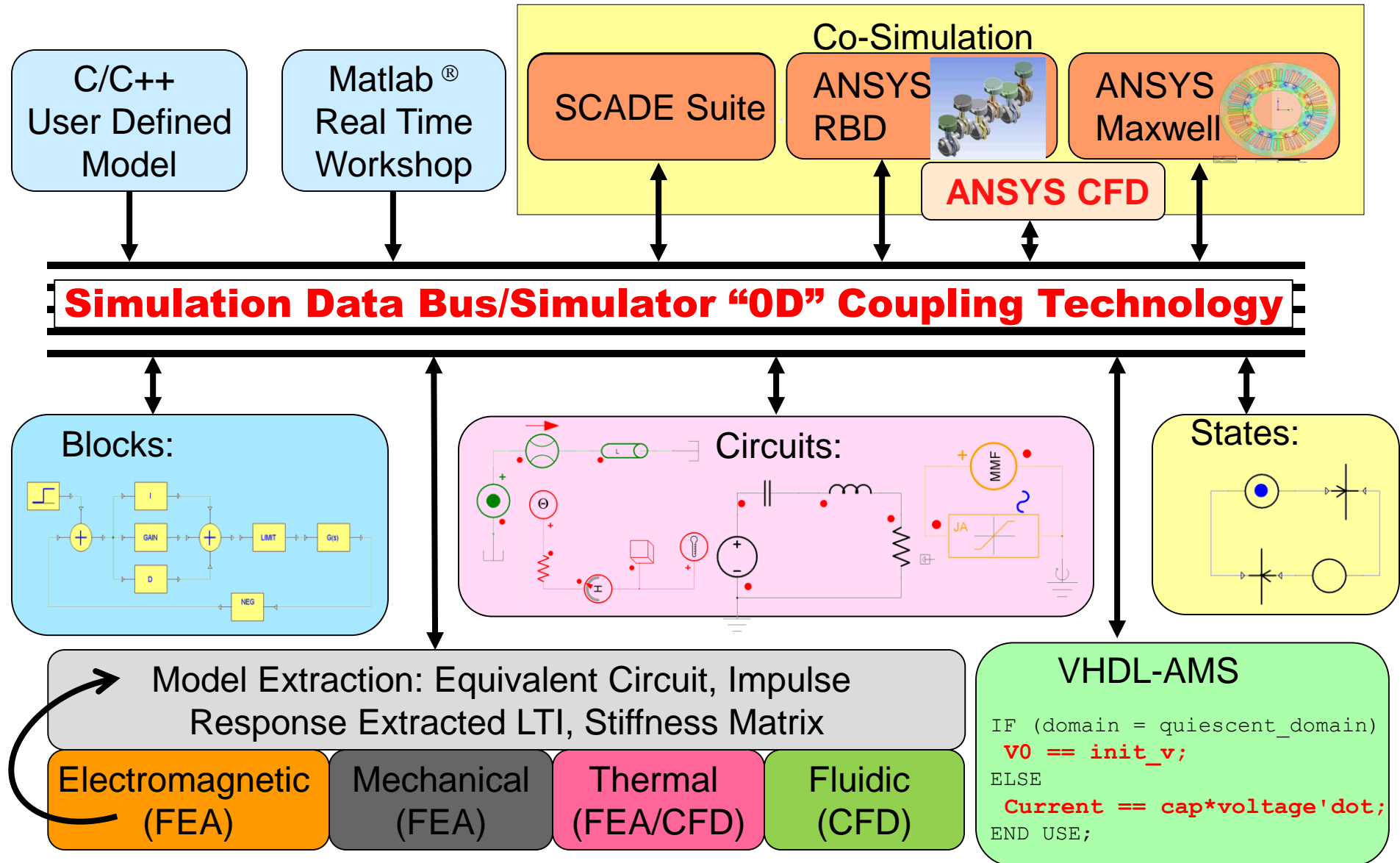
## What it is

- 3D/2D LF electromagnetics physics-based solver

## Applications

- Linear or rotational actuators
- Relays
- Magnetic recording heads
- Coils
- Permanent magnets
- Sensors
- Transformers
- Converters
- Bus bars
- Electrostatic discharge
- Electromagnetic shielding
- EMI/EMC
- Semiconductor
- Biomedical

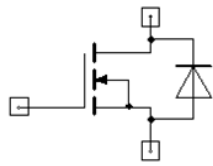
# ANSYS Simplorer



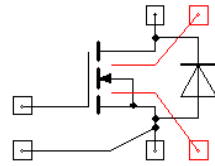
# Characterization Device Capability

Allows creation of a Simplorer component from a datasheet for

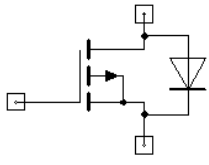
- IGBTs
- MOSFETs



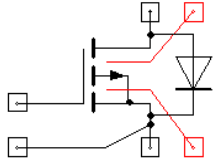
N-Channel



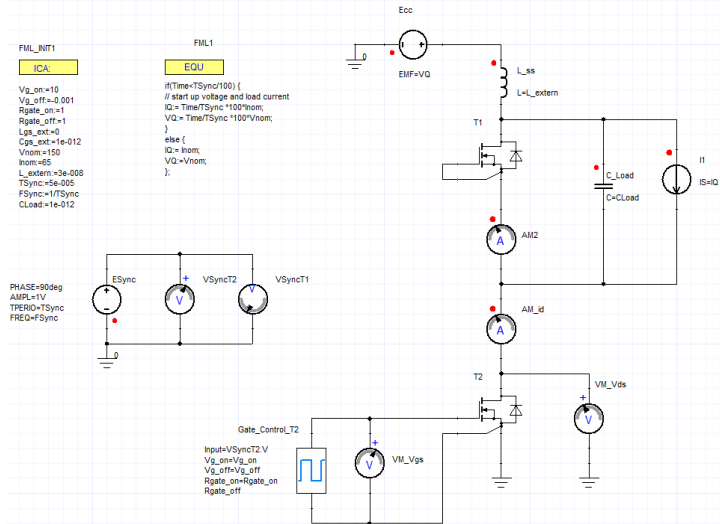
N-Channel w/Thermal Pins



P-Channel



P-Channel w/Thermal Pins



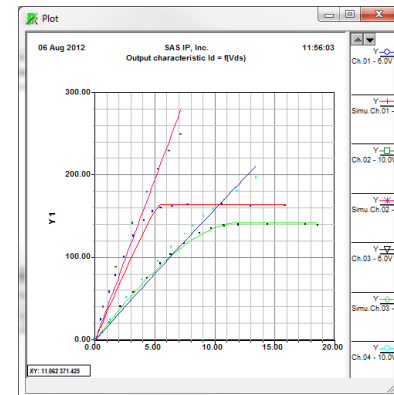
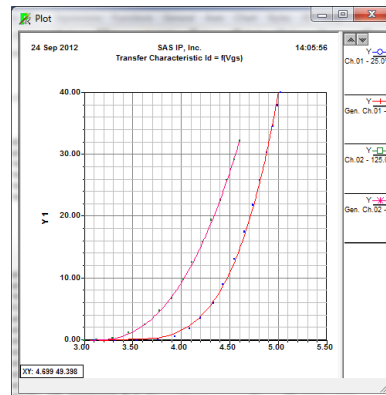
Manufacturer Data

Name: DYS

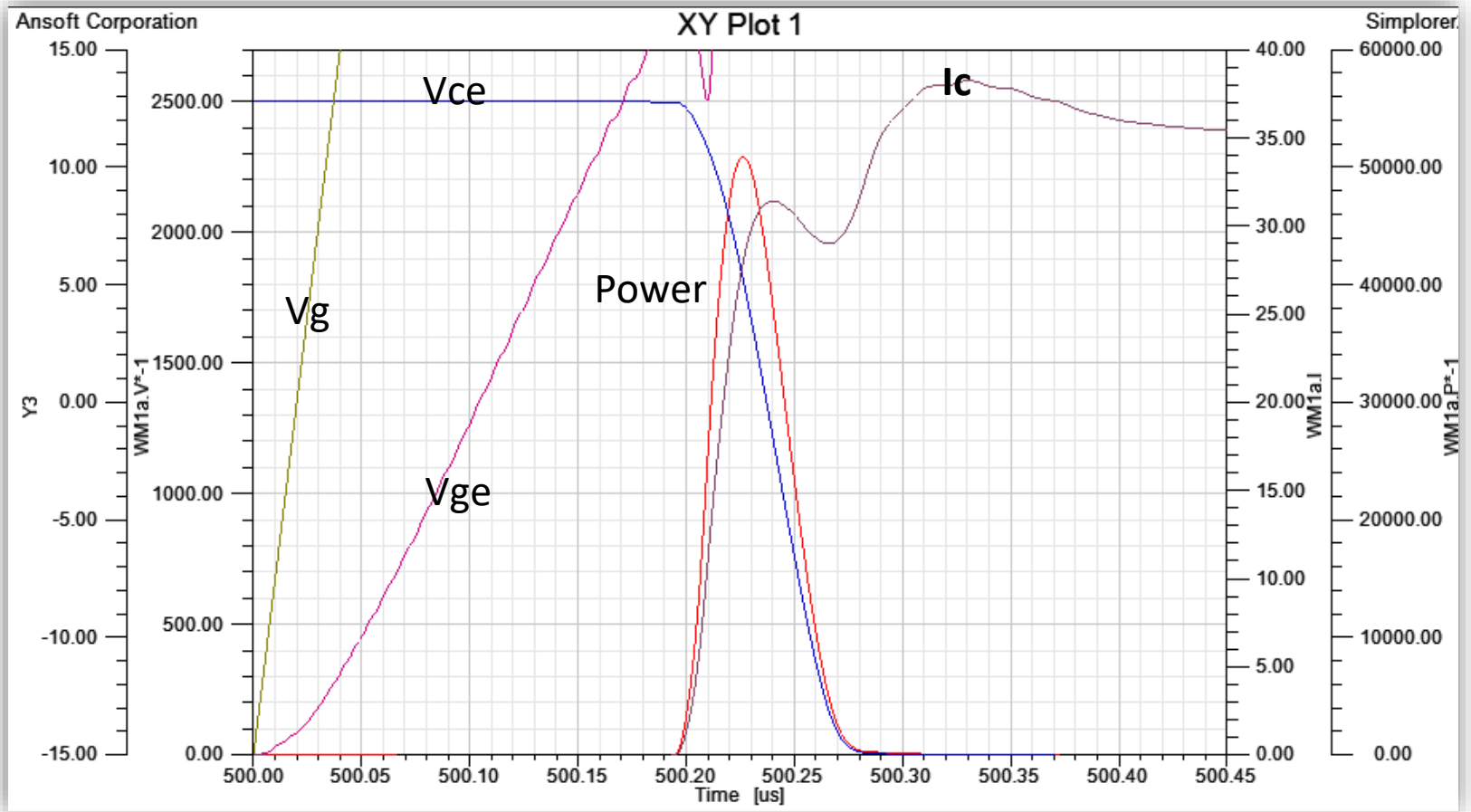
Switching Energy/Delay Time Measurement Criteria

Start Time	End Time
t(on): 10% rising VGS (VGS_min to VGS_r)	t(on): 10% falling VDS
t(off): zero crossing of rising ext. trigger signal	t(off): 90% rising VDS
t(off): 10% rising VGS (VGS_min to VGS_max)	Eon: 1% falling VDS
Eon: zero crossing VGS	Eoff: 3% falling ID
Eoff: 10% rising VGS (0 to VGS_max)	
Eoff: 90% falling VGS (VGS_max to 0)	

OK Cancel

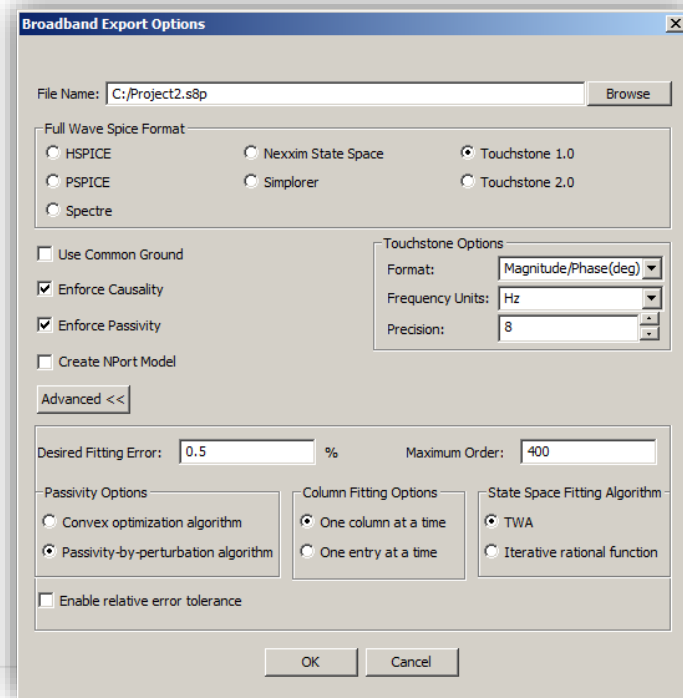
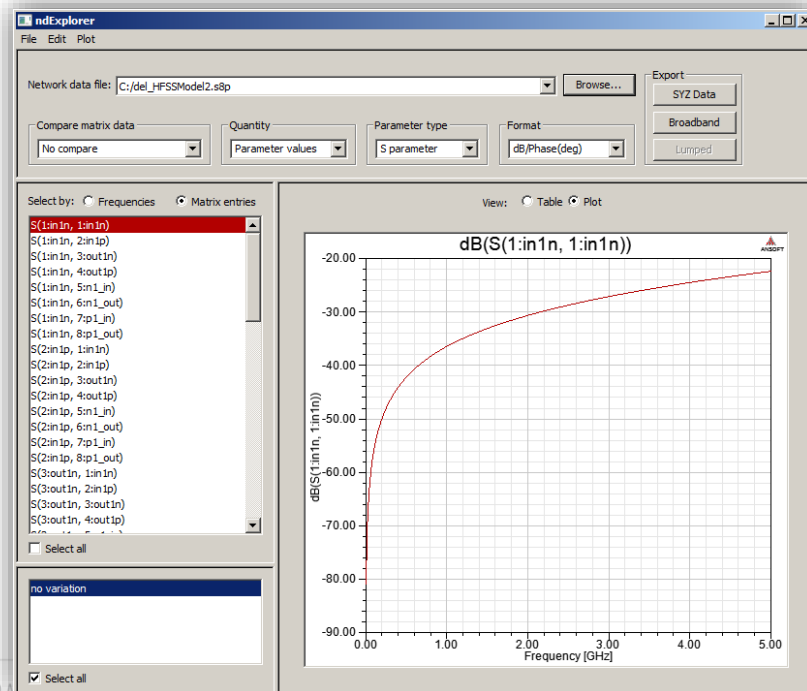


# Characterization Device Capability



# Simplorer Network Data (nD) Explorer

- Plots and data tables of S-parameter
  - Matrix entries and passivity information
  - Differential and Single ended S-parameters
  - A single model or a comparison between two models can be performed
  - Allows user to reduce order of S-parameter models by terminating selected ports and generating a new Touchstone file
  - Export fixed FWS file with enforced passivity and causality



# ANSYS Q3D Extractor

## Q3D Extractor Simulation Technology Quasi-Static Electromagnetics

Q3D Extractor Desktop

Boundary Element Method

Q3D Extractor

Capacitance/Conductance  
DC Resistance/Inductance  
AC Resistance/Inductance

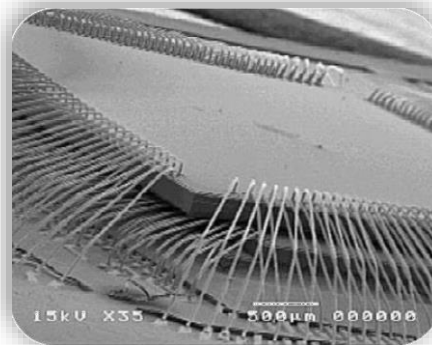
Finite Element Method

SI2D

Admittance (C/G)  
Impedance (R/L)

## Applications

- Packages
  - BGAs, SiP and PoPs
- IGBTs, FETs
- Touchscreen technologies
  - Capacitive sensing
- DDRx Memory Applications
- Flash memory



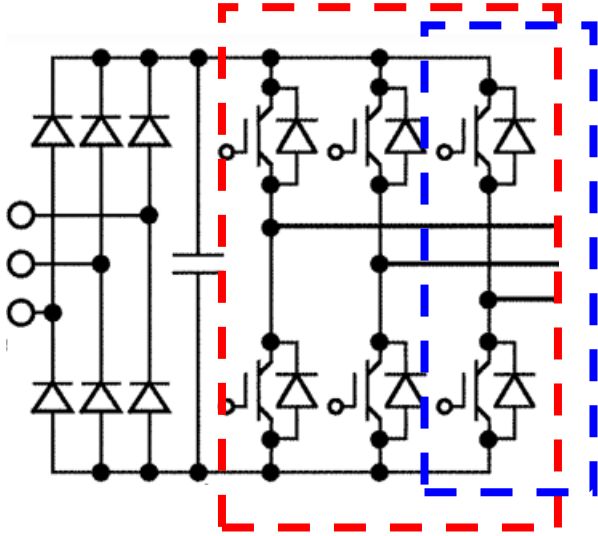


# Conductive Noise Simulation with Power Module and Cable

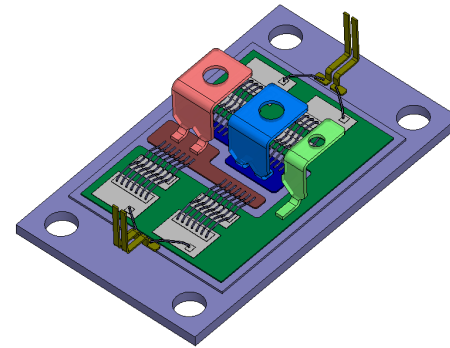
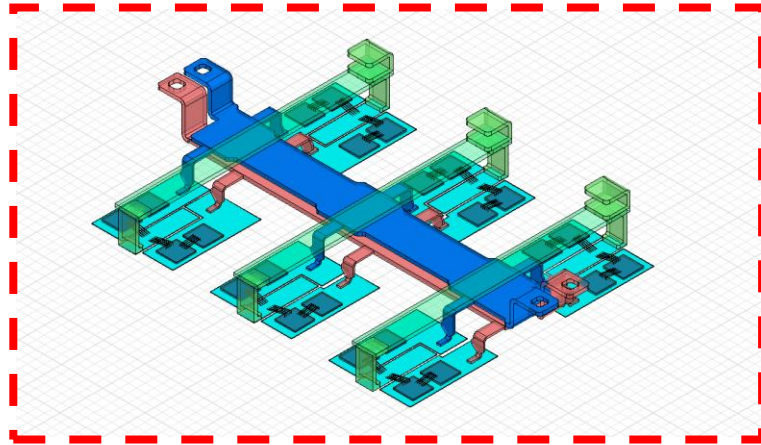


# Inverter Package Model

- 3 Phase Model
- 1 Phase Model

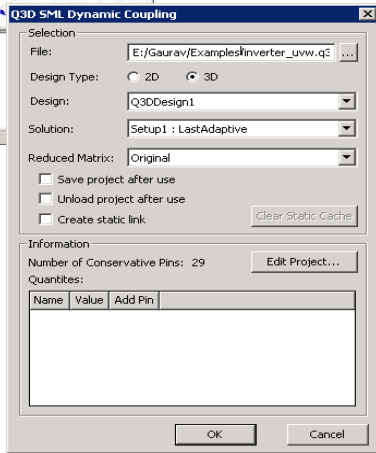
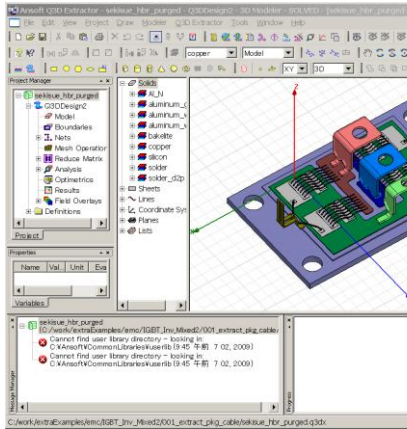


3 Phase Model



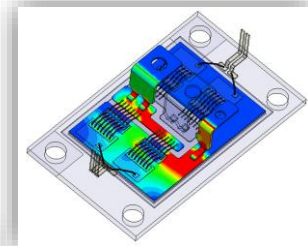
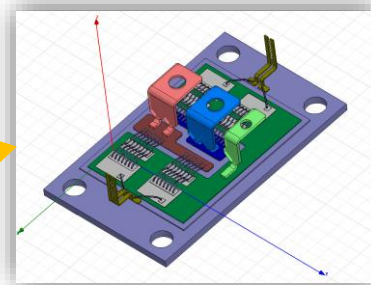
1 Phase Model

# Q3D Extractor + Simplorer

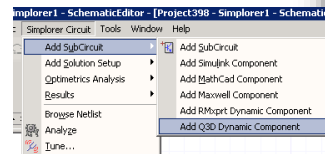
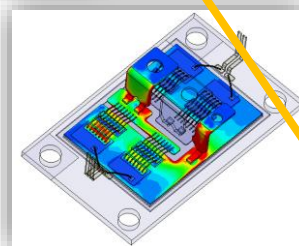


**Q3D Extractor  
(LCR extraction)  
Export**

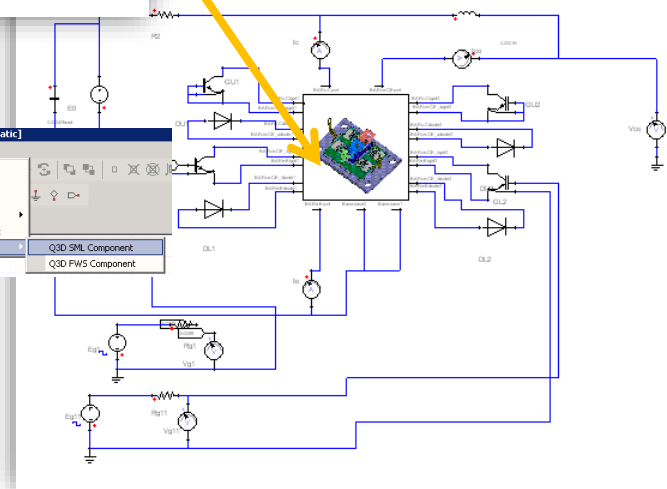
**State Space Model**



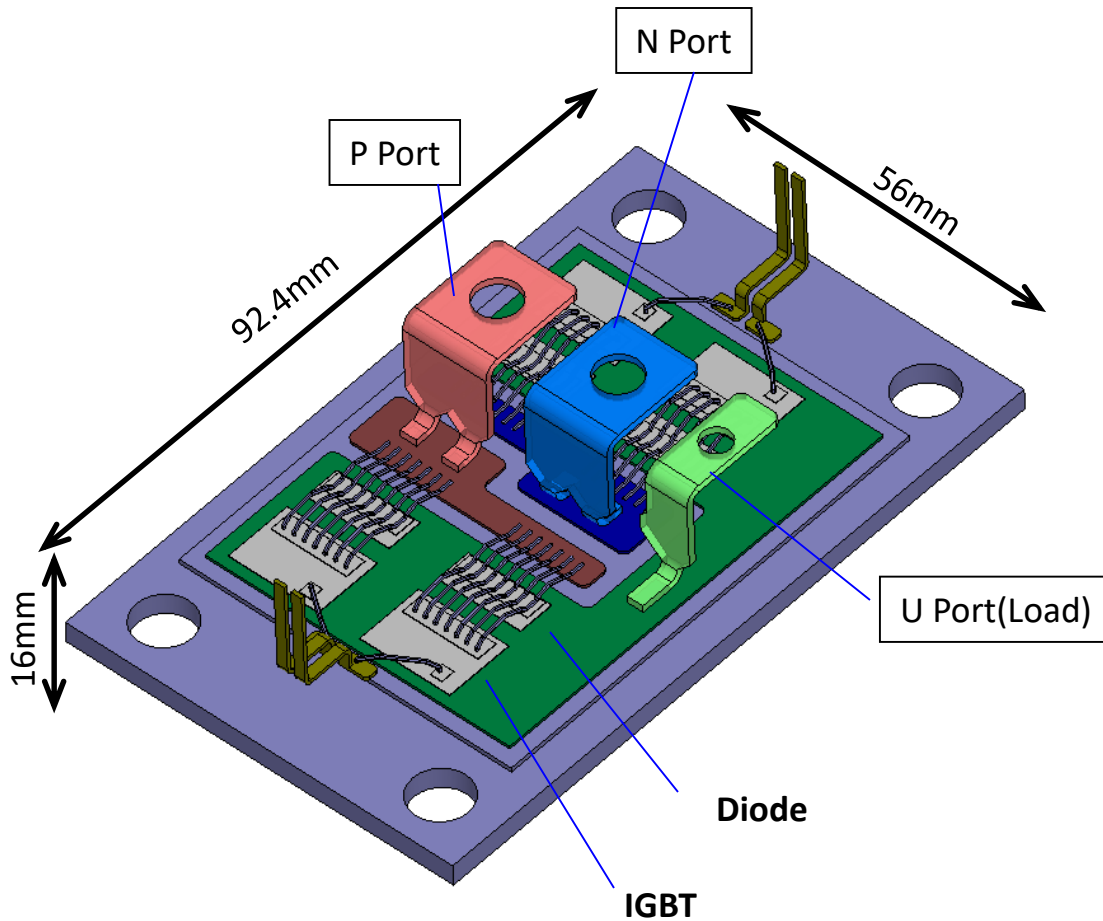
**Electromagnetics**



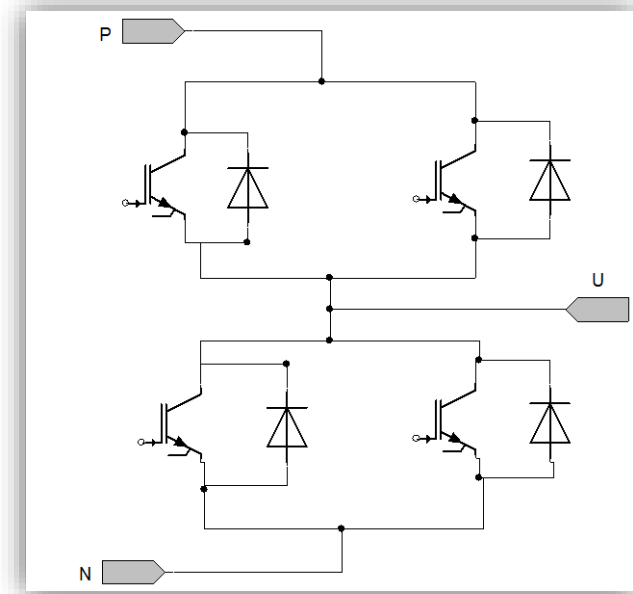
**Simplorer  
(Circuit)  
Import**



# Parasitic Parameter Extraction Model 1-Phase



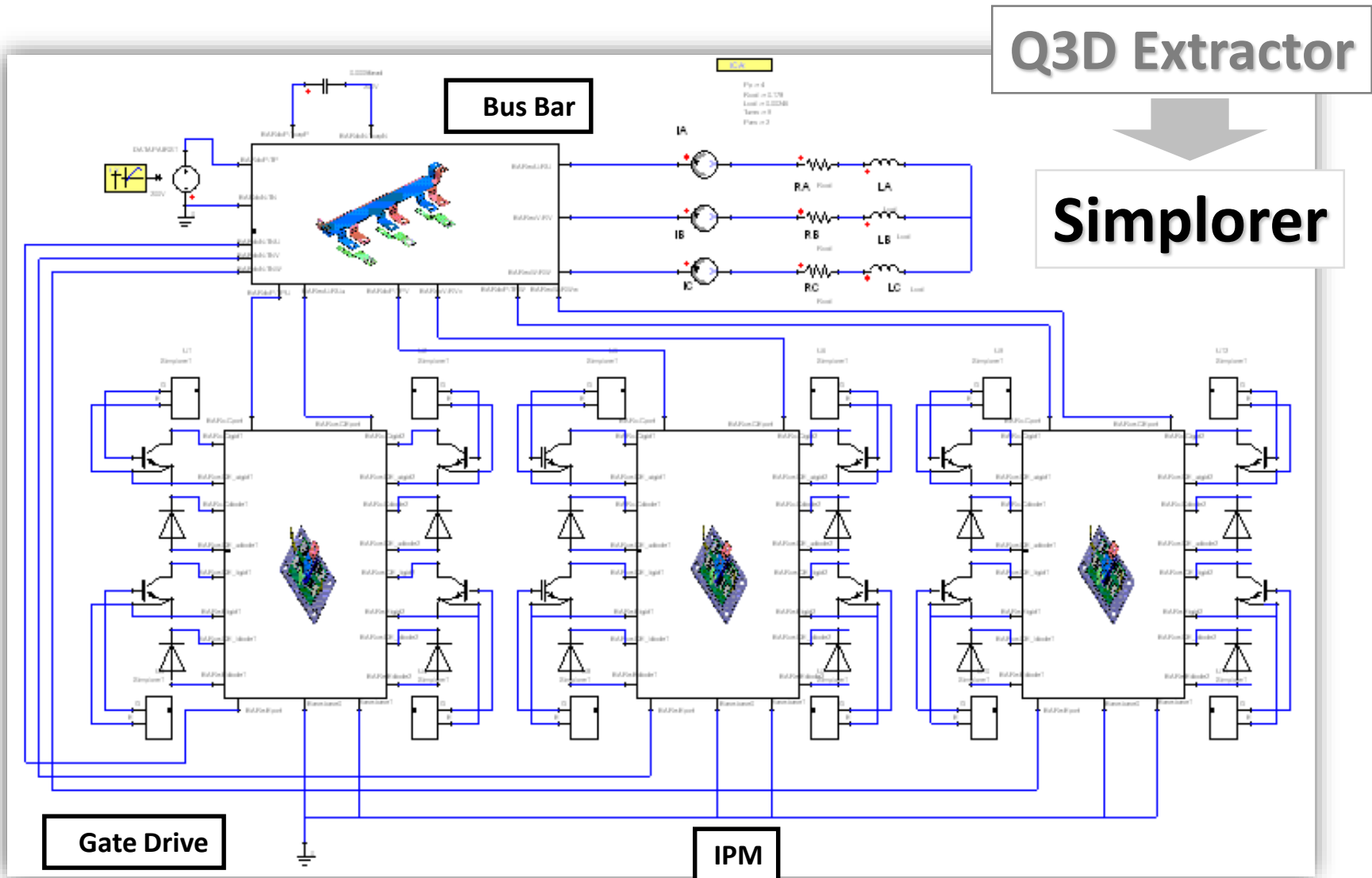
**Q3D Extractor**



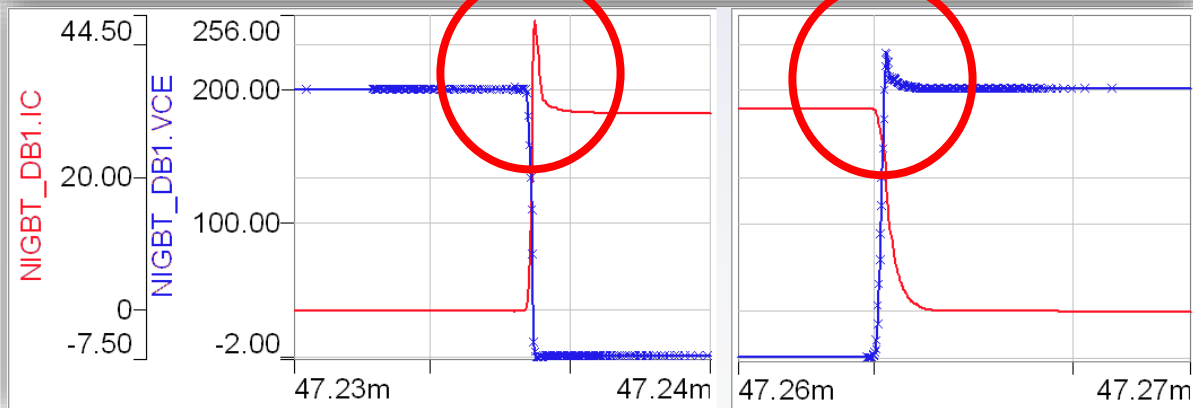
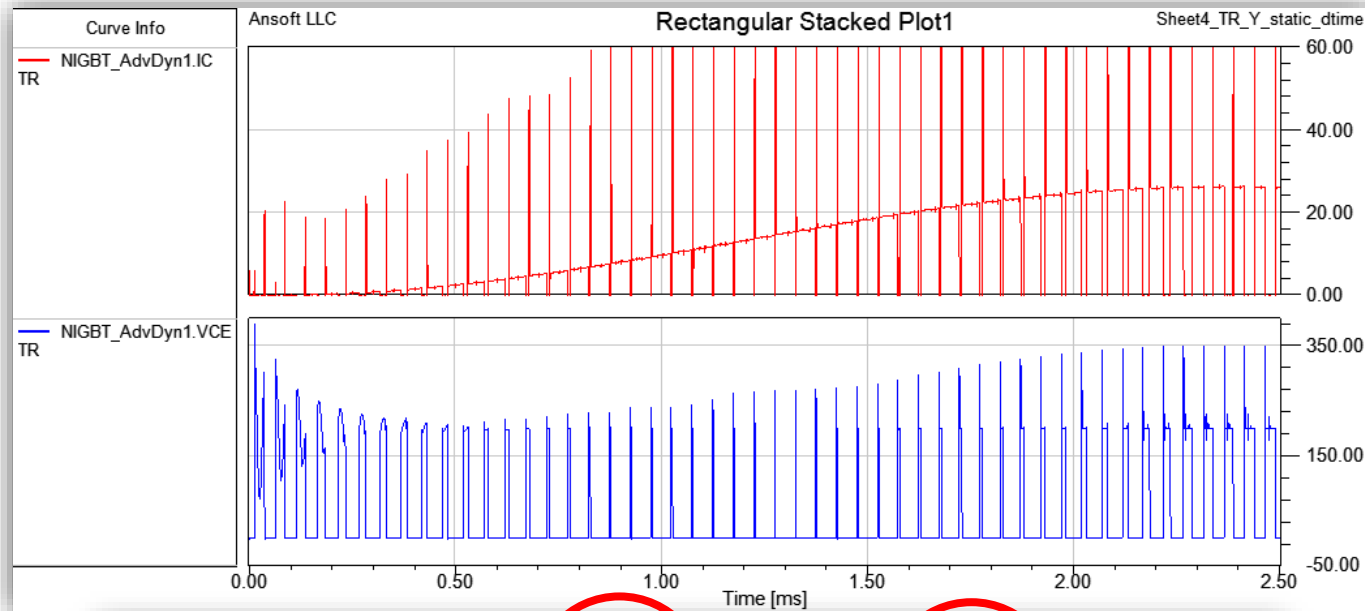
**Equivalent Circuit**

Bus bar, Base plate: Copper  
Bonding wire: Aluminum

# Definition of Inverter package circuit



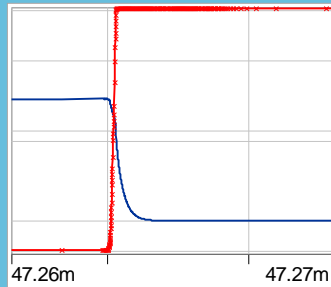
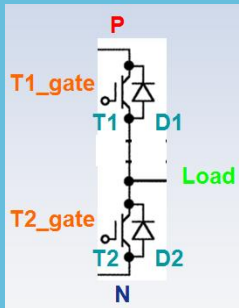
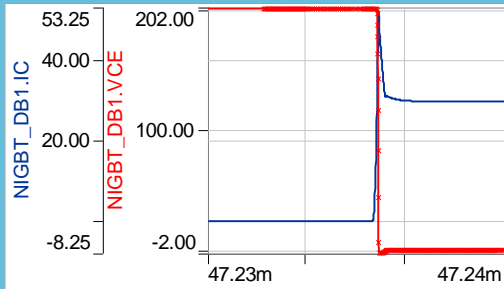
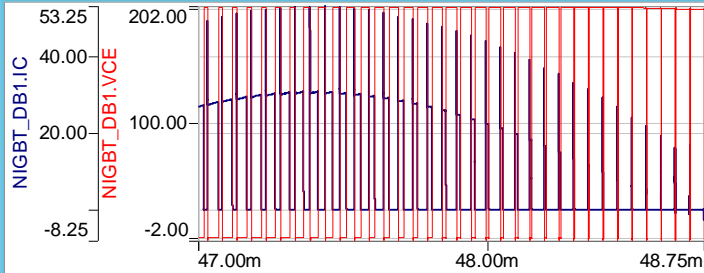
# Output switching waveform with considered extracted parameter



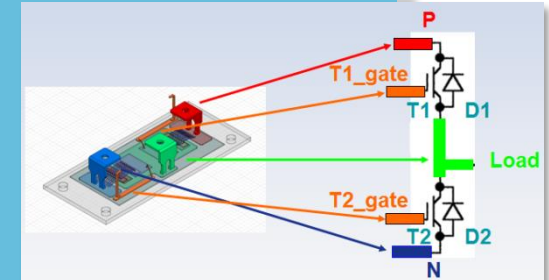
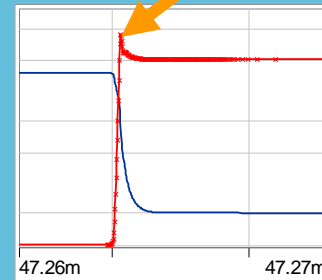
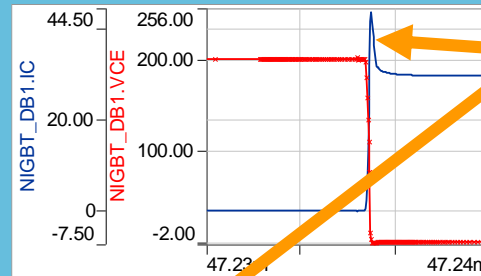
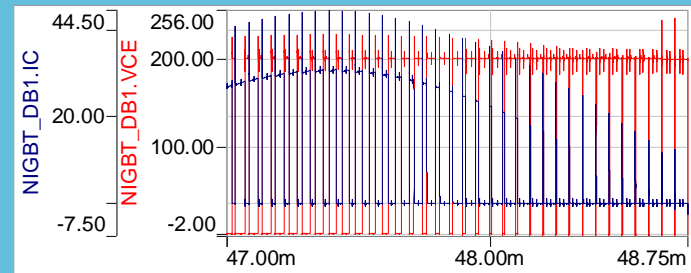
Surge and ringing waveform

Device Model + Parasitic parameter : Switching ON/OFF

# Compared with/without parasitic parameter



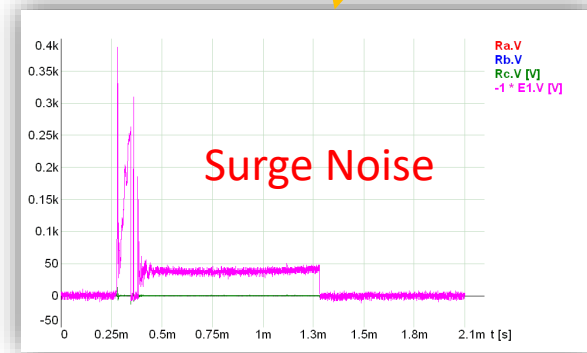
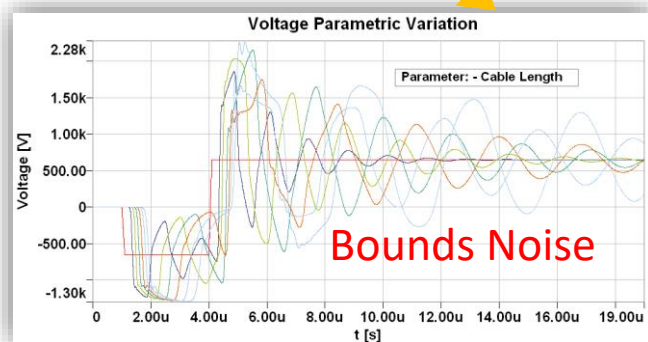
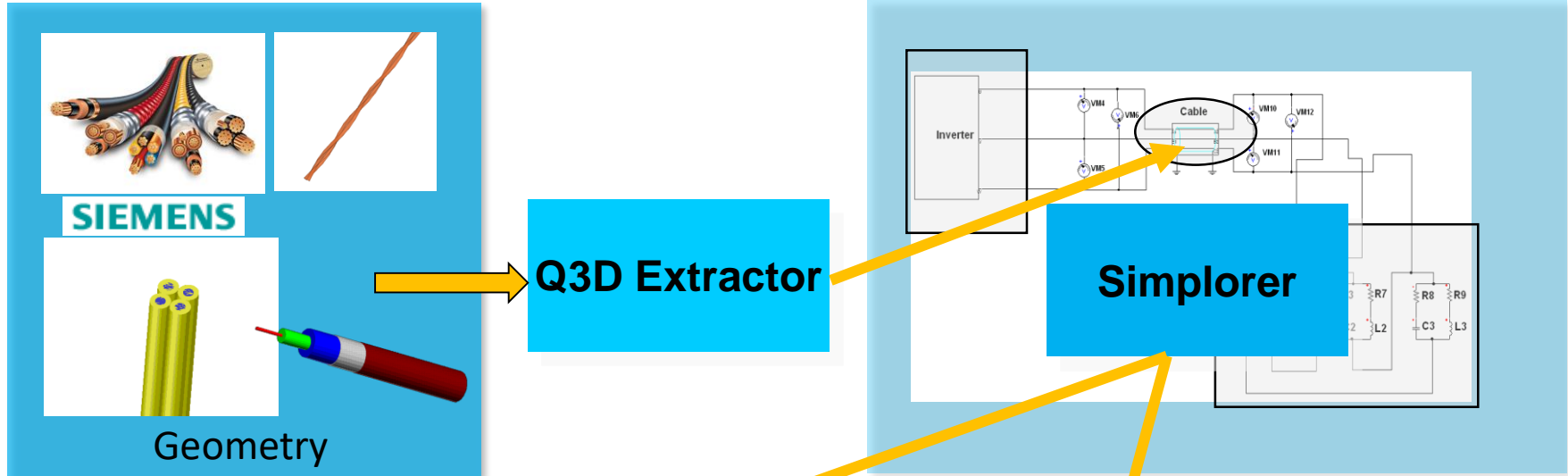
Without parasitic parameter



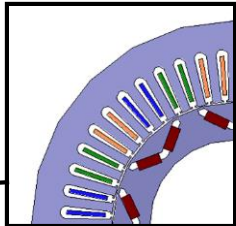
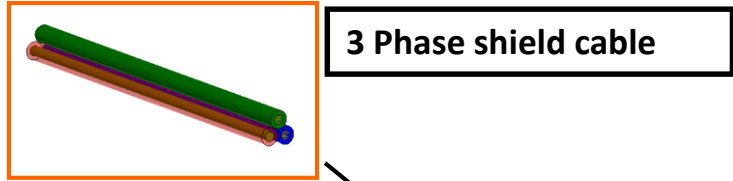
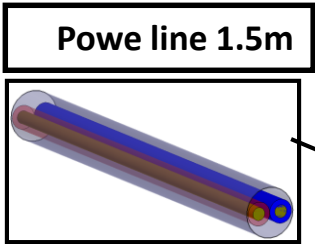
With parasitic parameter

# Cable Modeling

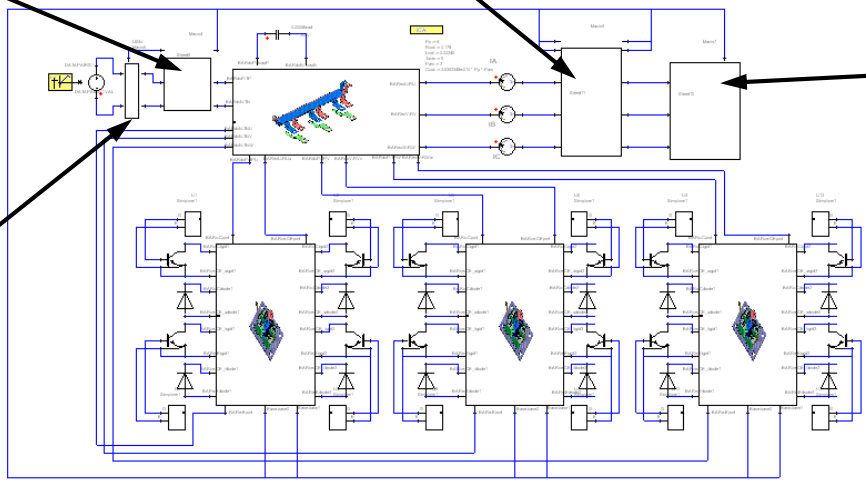
- Cable will be often called a noise main factor...



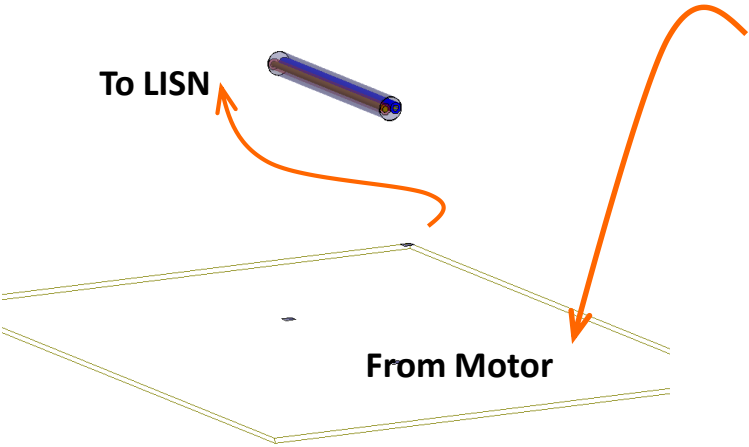
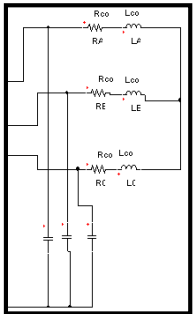
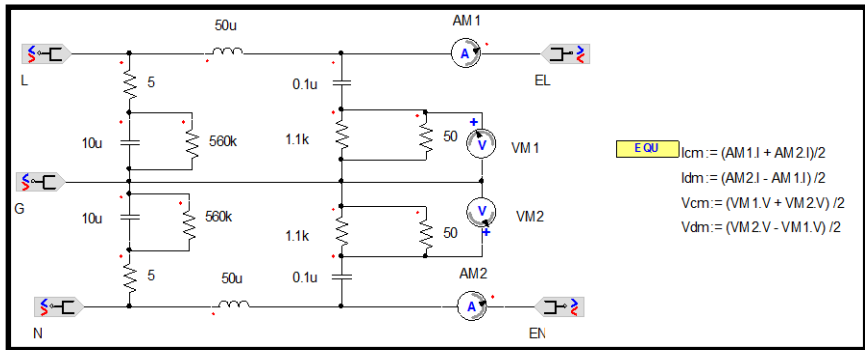
# Adding Floating Capacitance, Ground Loop, and LISN



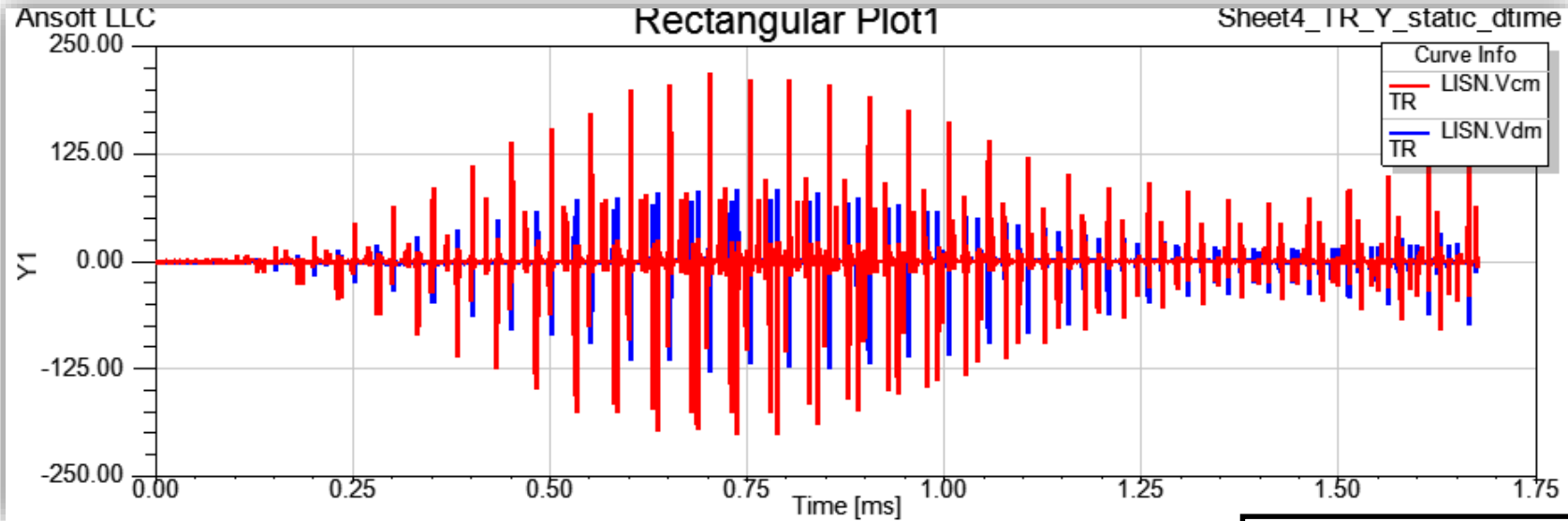
**Motor Winding coil, Floating C**



**LISN**



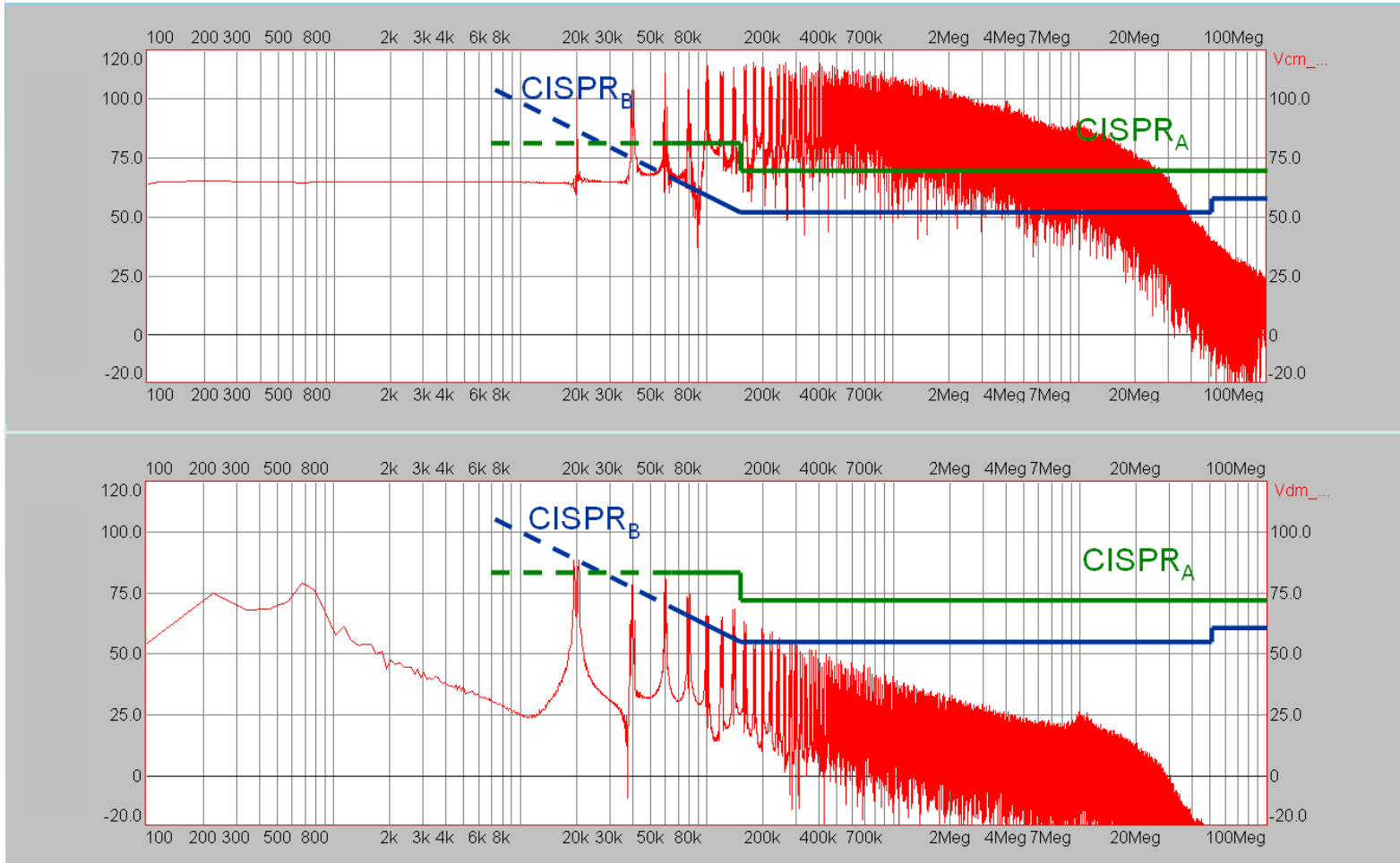
# Separate CM/DM Voltage by LISN



Common Mode Voltage(Vcm) , Differential Mode Voltage(Vdm)

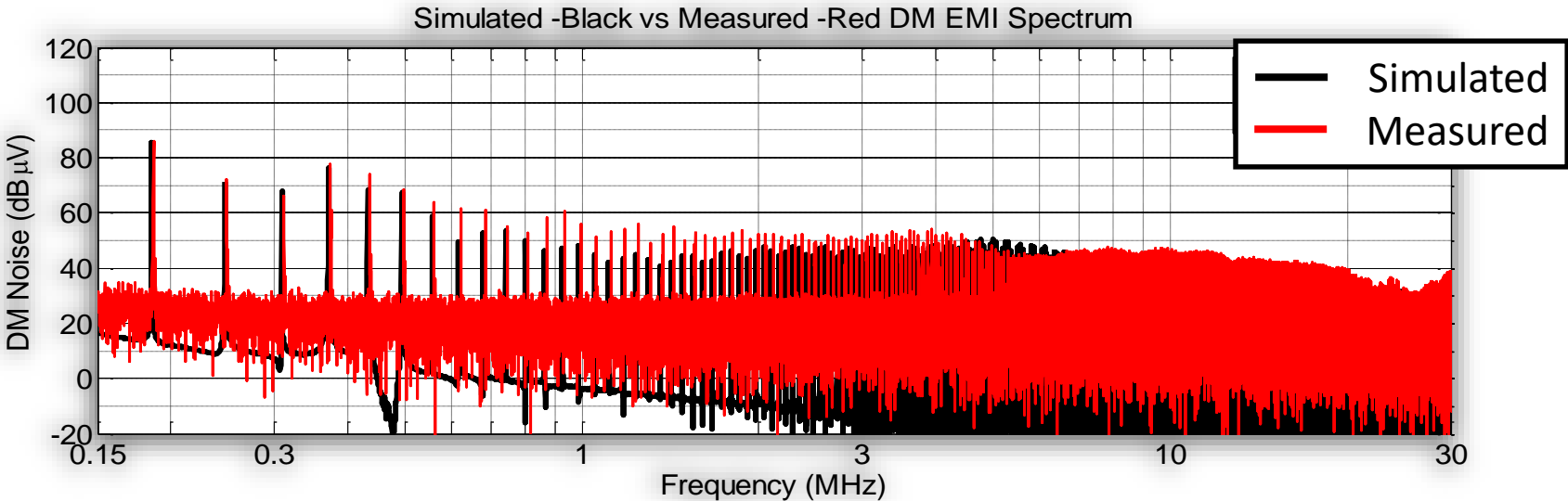
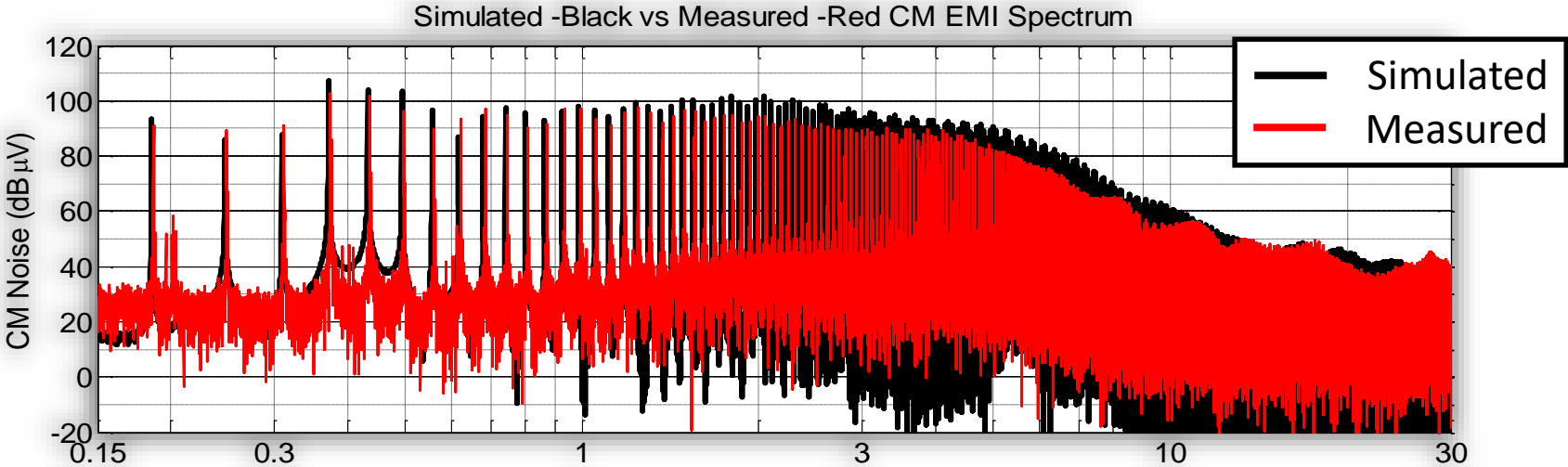
Waveform  
CM Voltage: **Vcm**  
DM Voltage: **Vdm**

# FFT: Waveform changes to Frequency domain

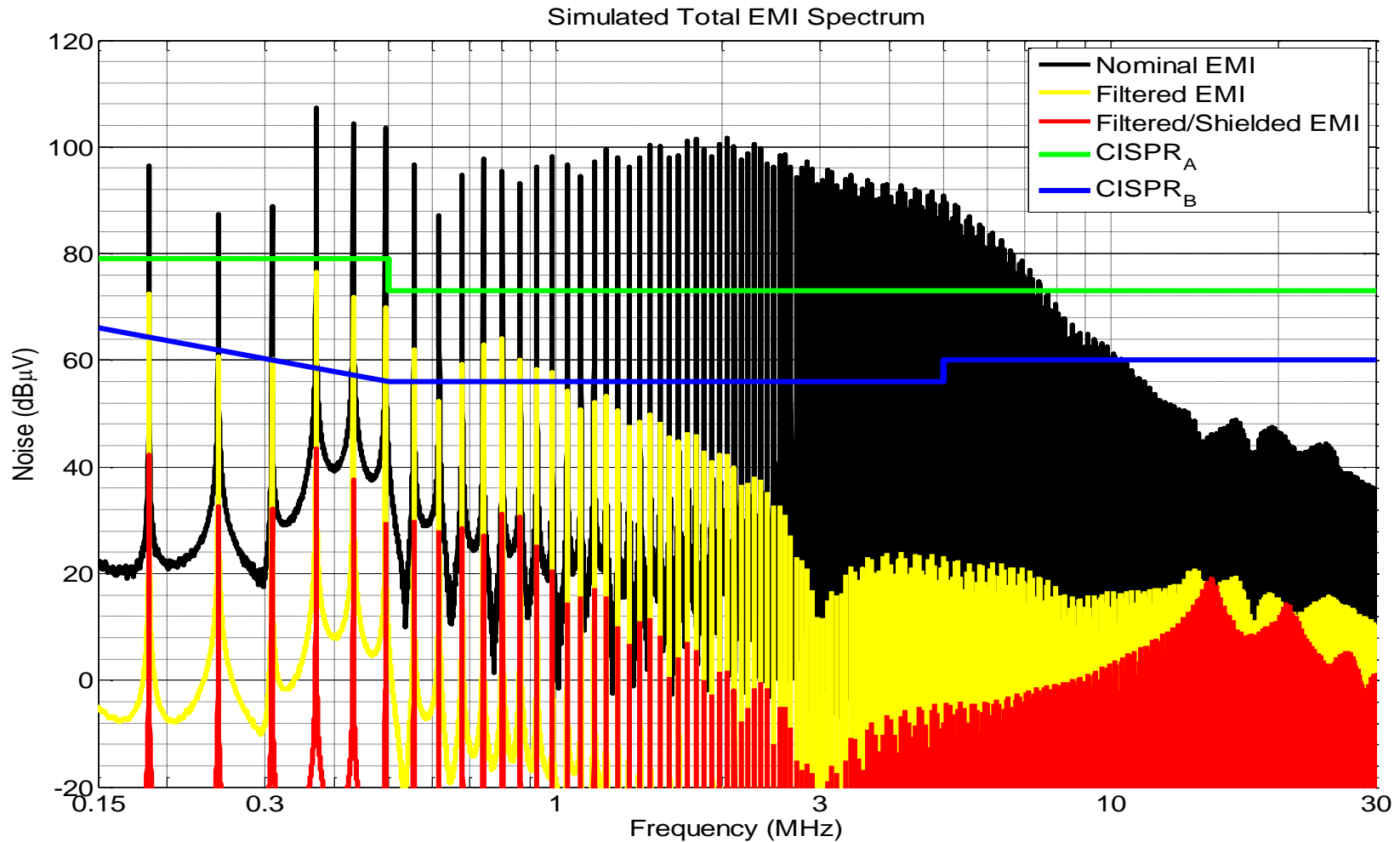


■ Common Mode Noise is over the CISPR regulations

# Compared with measurement results



# Virtual Prototype Design



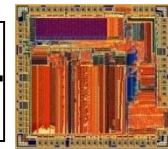
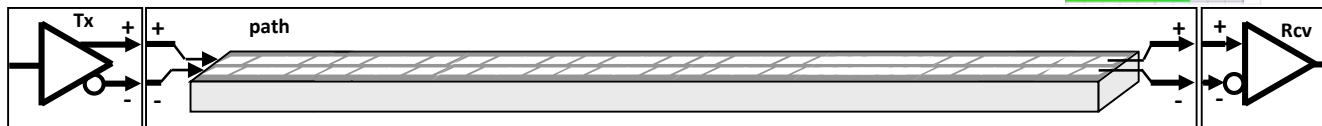
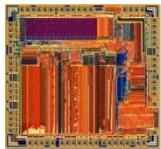
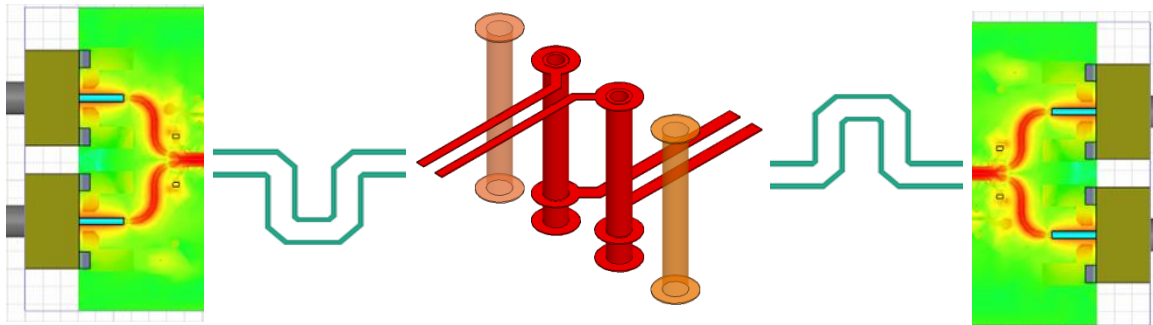
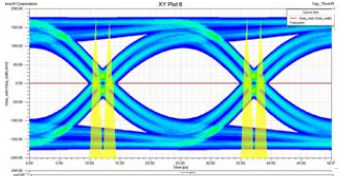
**ANSYS**<sup>®</sup>

# Low Frequency Signal Integrity



# Signal Integrity – Channel

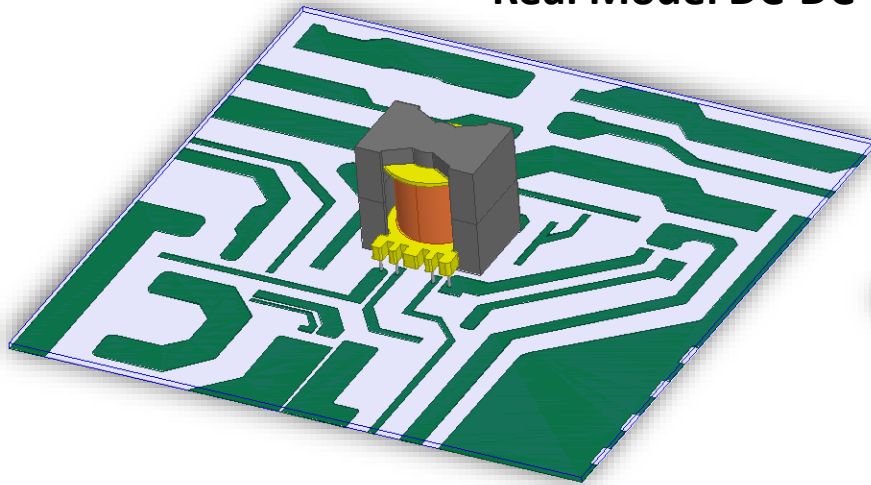
- Set of measures of the quality of an electrical signal (stream of binary values represented by voltage or current)
- Signal will see many discontinuities in its path
- Discontinuities will distort signal quality and reduce overall bandwidth of the system



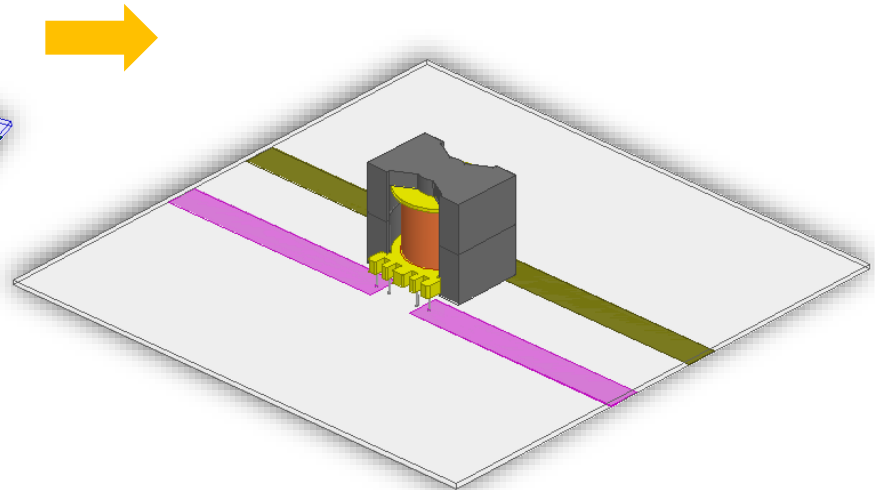
# Low Frequency Signal Integrity

- What/How is the critical source of conducting noise on the
- power supply PCB?

Real Model DC-DC



Virtual Test Model



Inductor – Trace Coupling ?

Trace-Trace coupling ?

# Step-by-Step Investigation

## 1. Electromagnetics

1. Coil inductance (nonlinear) saturation (Maxwell)
2. PCB Trace-to-Trace coupling (Q3D Extractor)
3. Coil-to-Trace coupling (Maxwell)

## 2. Circuit

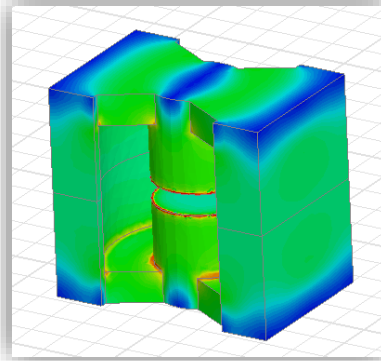
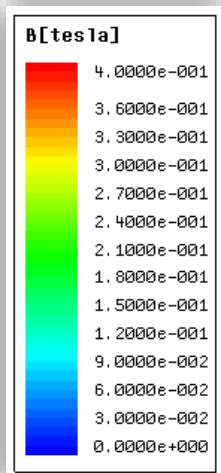
1. Noise by Circuit + LRCK model (Simplorer)
2. Noise by Circuit + EM (Q3D & Maxwell) model

# Analysis : EM 1-1 Saturation Characteristic

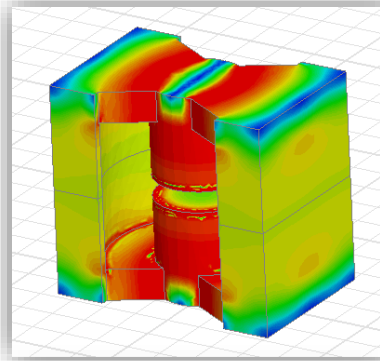
## Maxwell

- B distribution around the core @10A
  - Start to saturate 0.4T~ over 20A

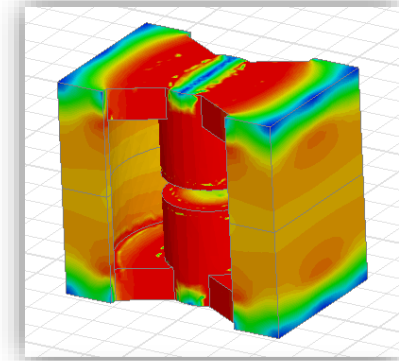
Max. 0.4[T]



20A



40A

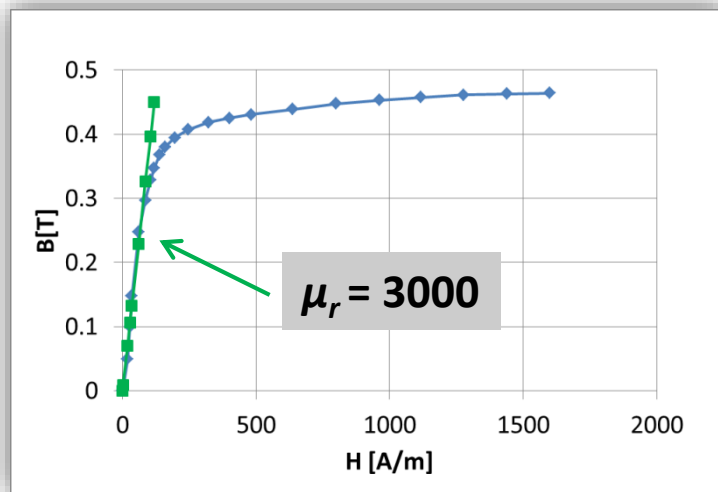


50A

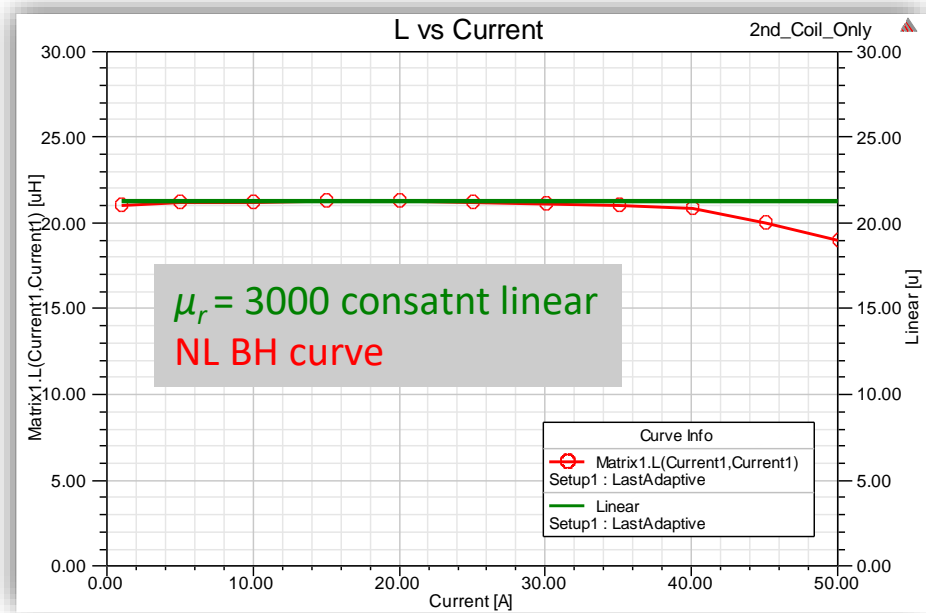
# Analysis : EM 1-1 Saturation Characteristic

## Maxwell

- Can be linear up to 10A ?
  - Yes, possible to be linear up to 30A for circuit simulation



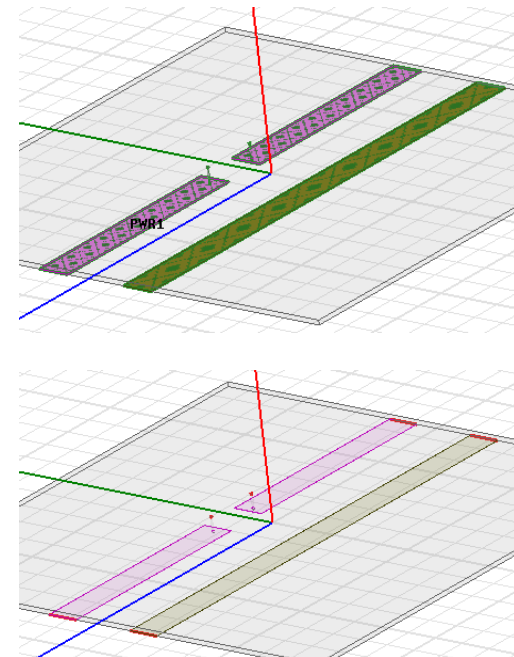
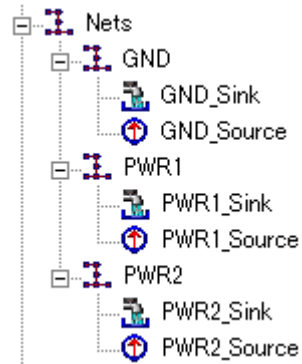
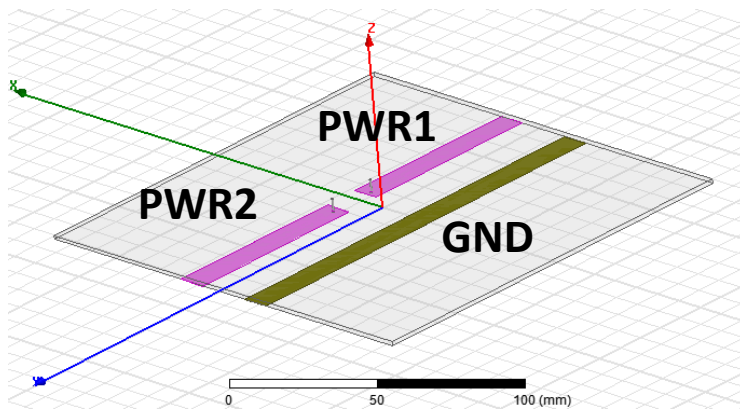
BH of core material



Simulated Inductance

# Analysis : EM 1-2 Trace-Trace coupling

## Q3D Extractor

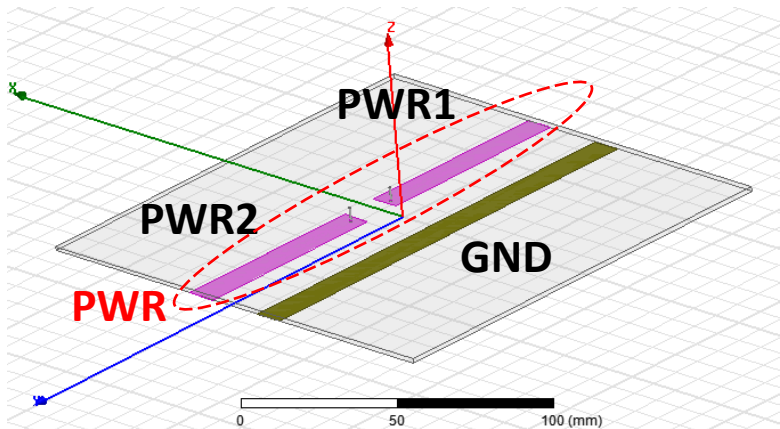


Source , Sink

# Analysis : EM 1-2 Trace-Trace coupling

## Q3D Extractor

- Matrix Reduction
- PWR1 and PWR2 are merged into one , then evaluate M, k with GND



Inductance    Units: nH    Original     All Freqs  
 Passivity Tolerance: .0001    Check Passivity    Equivalent Circuit Expo

	GND:GND_Source	PWR1:PWR1_Source	PWR2:PWR2_Source
Freq: 0.1 (MHz)			
GND:GND_Source	143.86	21.983	21.982
PWR1:PWR1_Source	21.983	47.466	6.2798
PWR2:PWR2_Source	21.982	6.2798	47.472



Inductance    Units: nH    RM1     All Freqs  
 Passivity Tolerance: .0001    Check Passivity

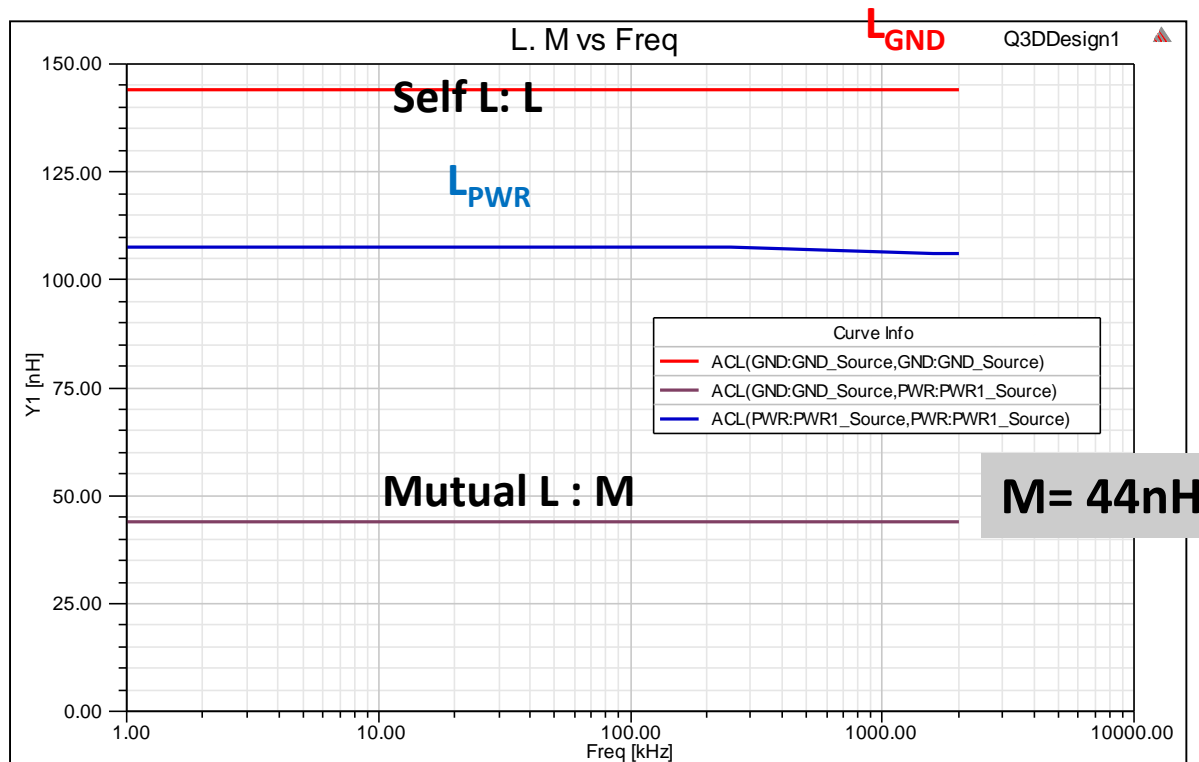
	GND:GND_Source	PWR:PWR1_Source
Freq: 0.1 (MHz)		
GND:GND_Source	143.86	43.966
PWR:PWR1_Source	43.966	107.5

$L_{GND}$      $M$   
 $M$      $L_{PWR}$

# Analysis : EM 1-2 Trace-Trace coupling

## Q3D Extractor

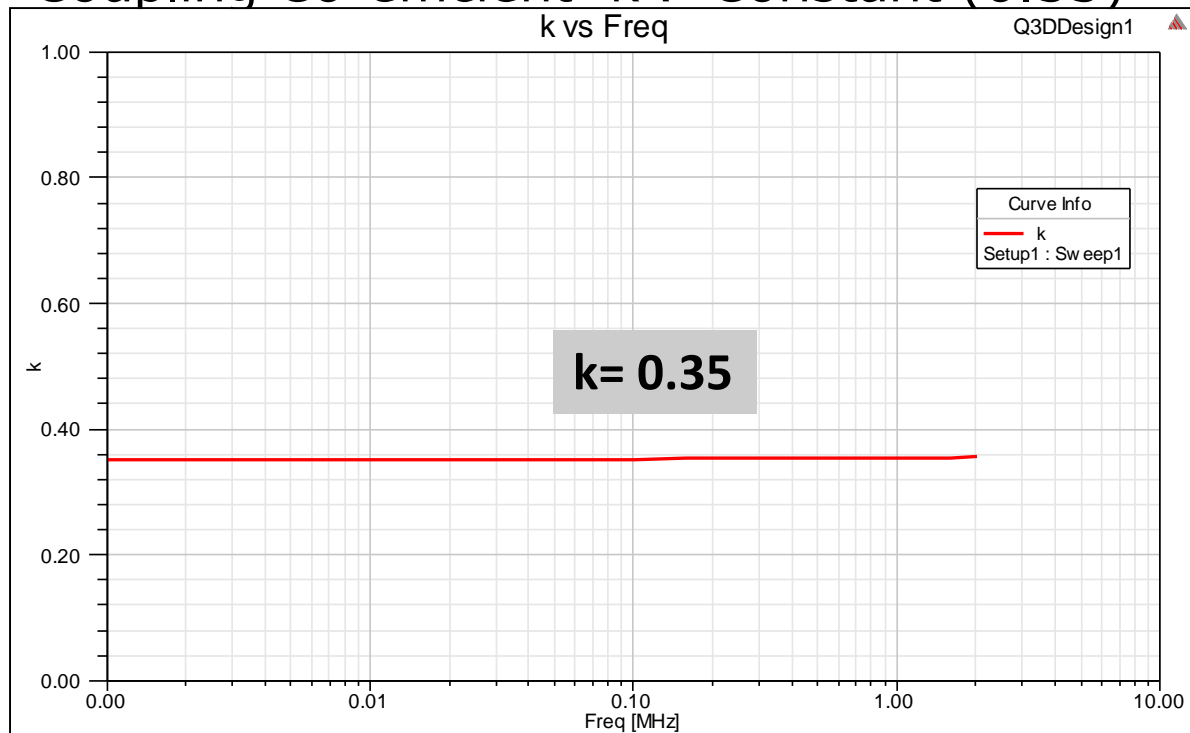
- Result : Self/Mutual inductance (AC)
- Mutual Inductance M : Constant (44nH)



# Analysis : EM 1-2 Trace-Trace coupling

## Q3D Extractor

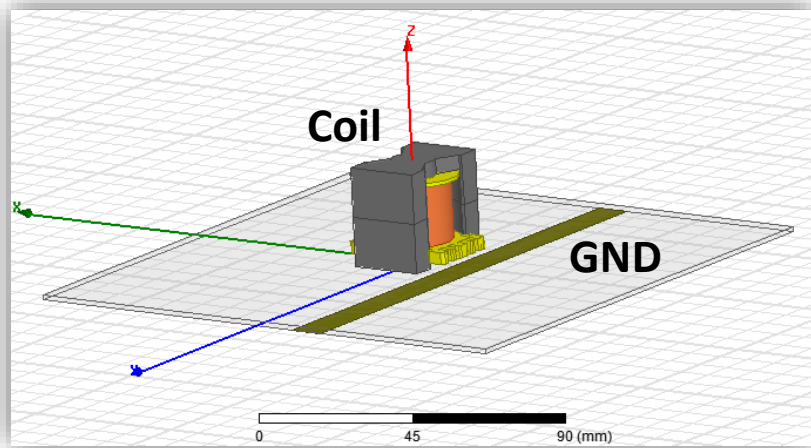
- Result : k (AC)
- Coupling Co-efficient k : Constant (0.35)



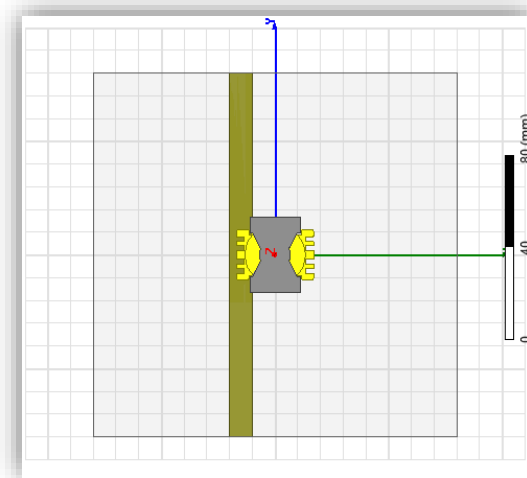
# Analysis : EM 1-3 Coil -Trace coupling

## Maxwell

- Mutual Inductance ( $M$ ) and Coupling Co-efficient ( $k$ ) between the coil and GND trace
- are evaluated
- Magnetostatic 1A~50A



Simulation model

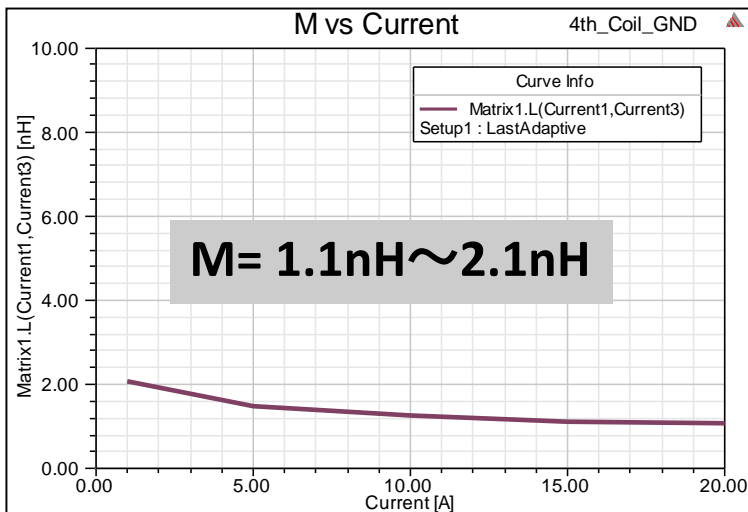


Top View

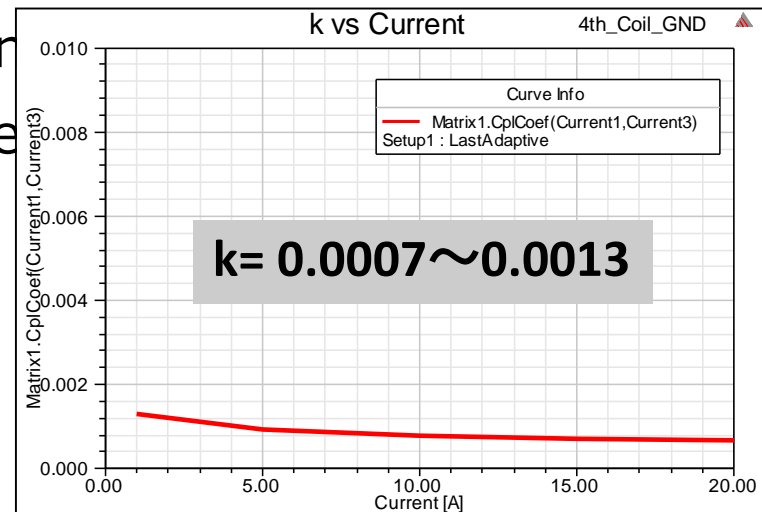
# Analysis : EM 1-3 Coil -Trace coupling

## Maxwell

- Result : Mutual Inductance (M) , Coupling Co-efficient (K) @1A ~20A
- Mutual Inductance (M) : 1.1nH~2.1nH
- Coupling Co-efficient : 0.0013~0.0007



Mutual Inductance (M)

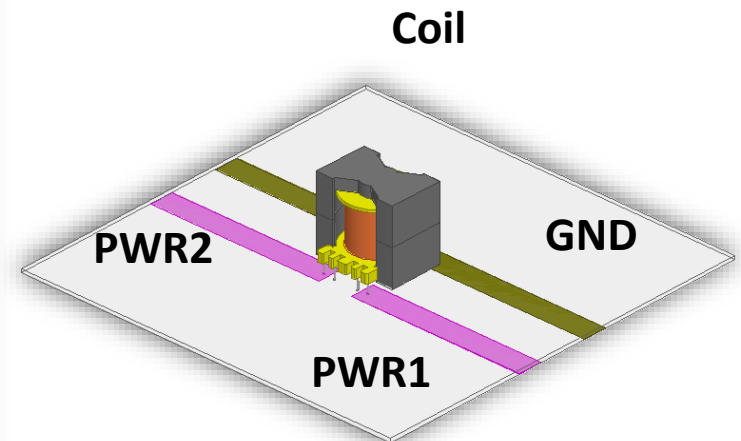
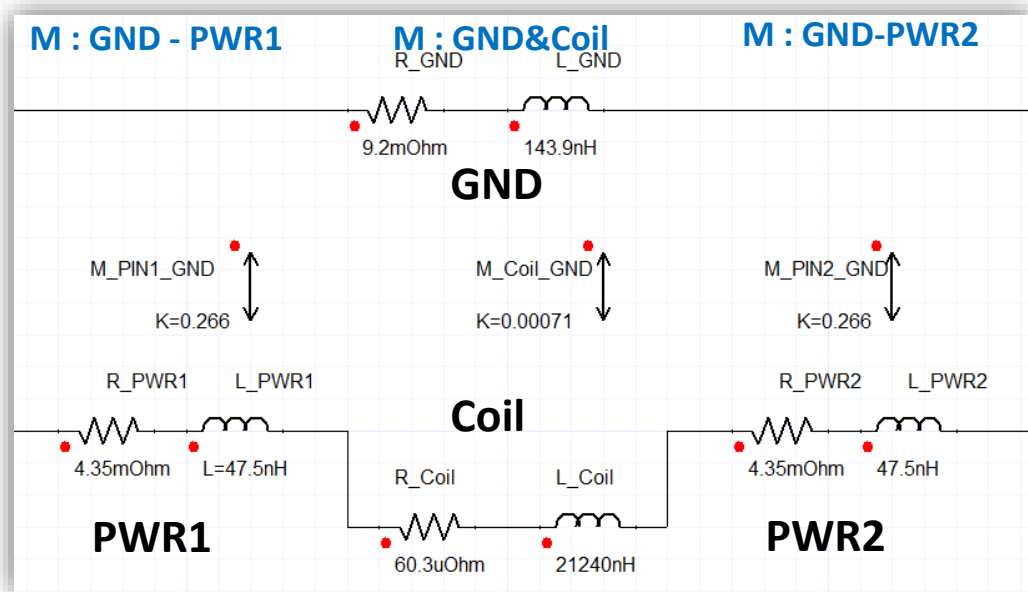


Coupling CO-efficient (k)

# Analysis : Circuit 2-1 Equivalent Circuit

## Simplorer

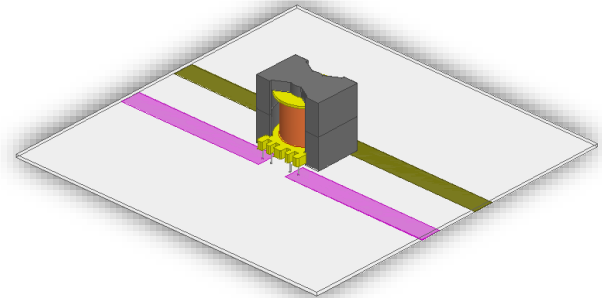
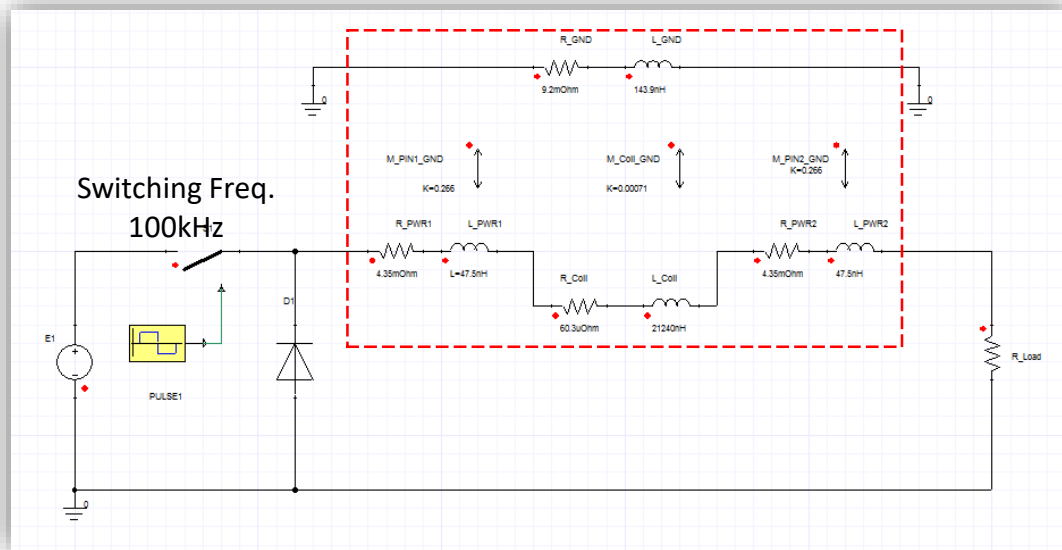
- Simple Circuit ①
  - Equivalent Circuit with extracted R,L,M



# Analysis : Circuit 2-1 Equivalent Circuit

## Simplorer

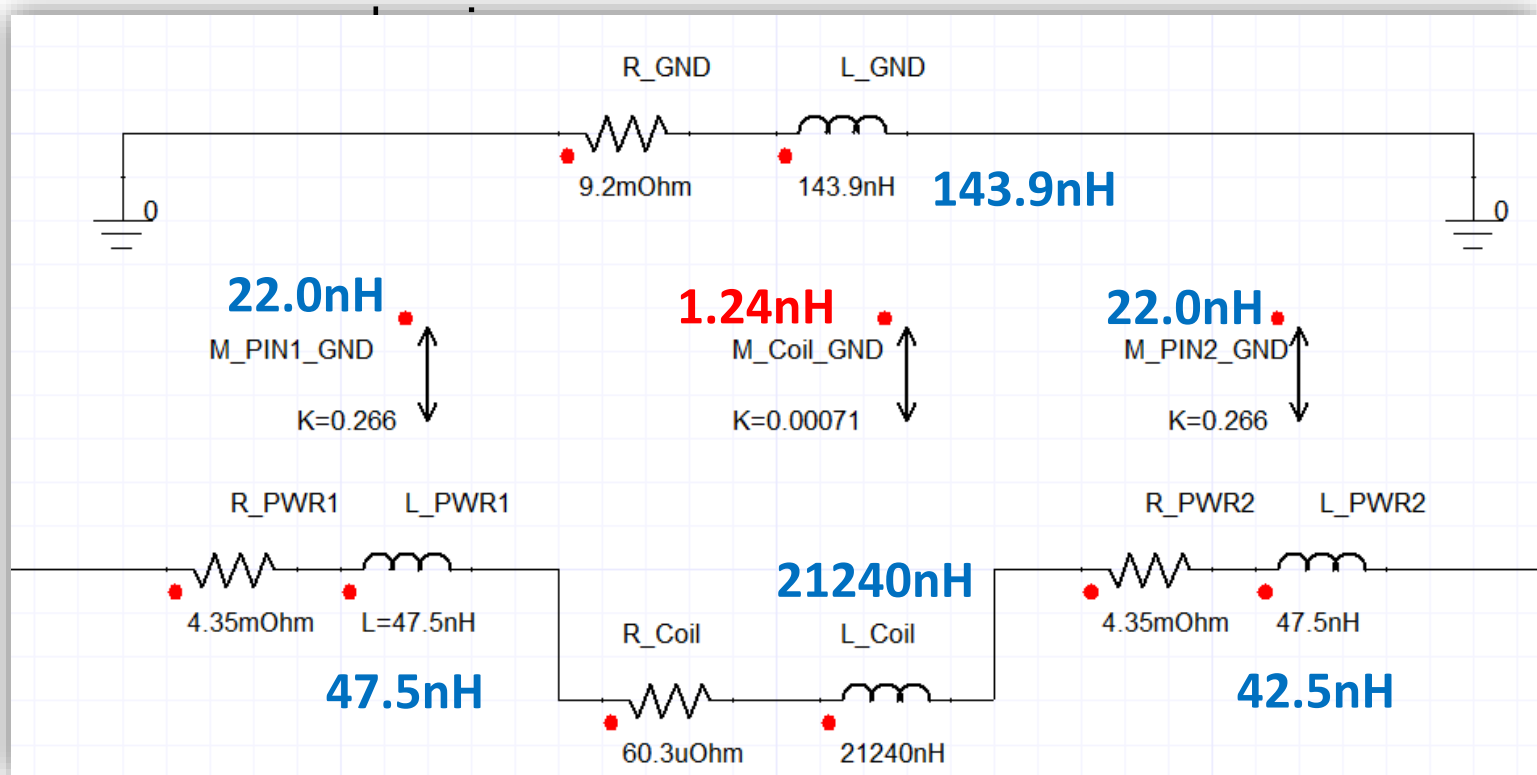
- Switching Voltage Power is applied in the power line (Coil) and current in the GND Line is evaluated. (Induced Current  $\Rightarrow$  Induced Noise)
- **Can easily identify the dominant inductance for Inductive Noise**



# Analysis : Circuit 2-1 Equivalent Circuit

## Simplorer

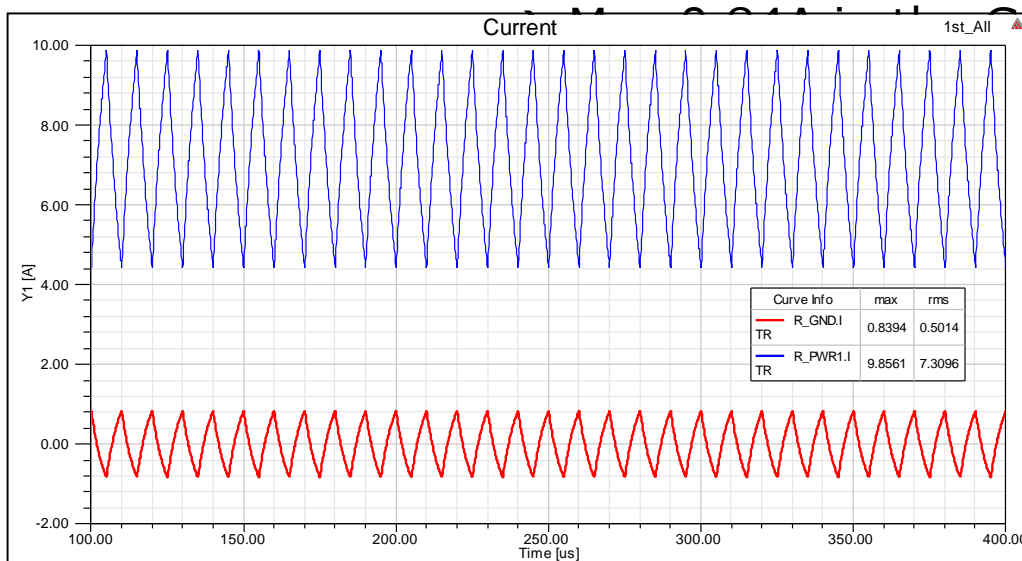
- Simple Equivalent Circuit
- Analyze / Identify the dominant factor of the induced



# Analysis : Circuit 2-1 Equivalent Circuit

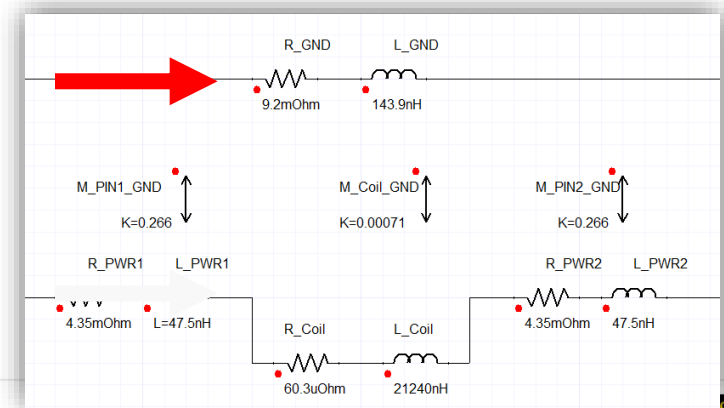
## Simplorer

- Result ① : Current in the Power Line and Induced current in the GND Line



GND Line @ Max. 10A in the Coil, PWR Line Current

GND Line Current (Induced Noise)

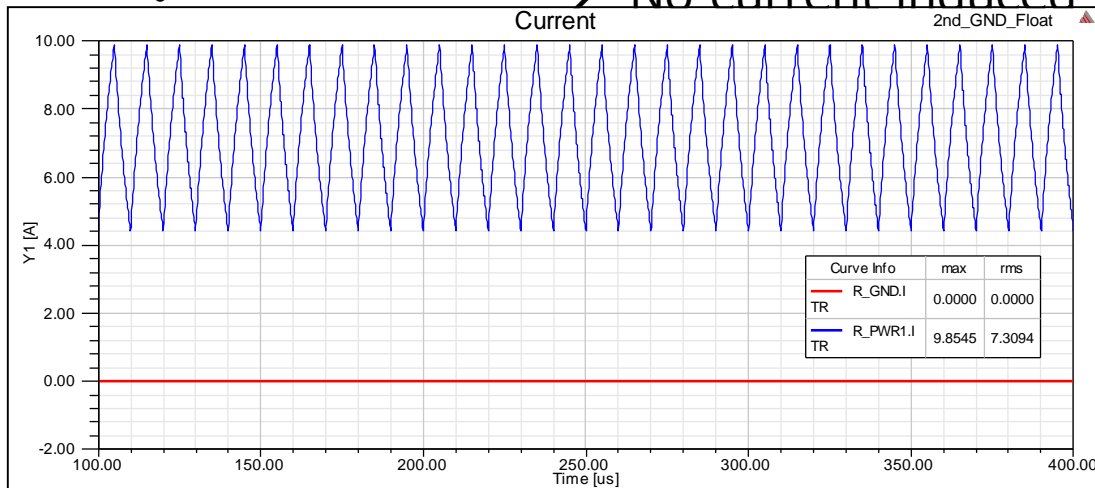


# Analysis : Circuit 2-1 Equivalent Circuit

## Simplorer

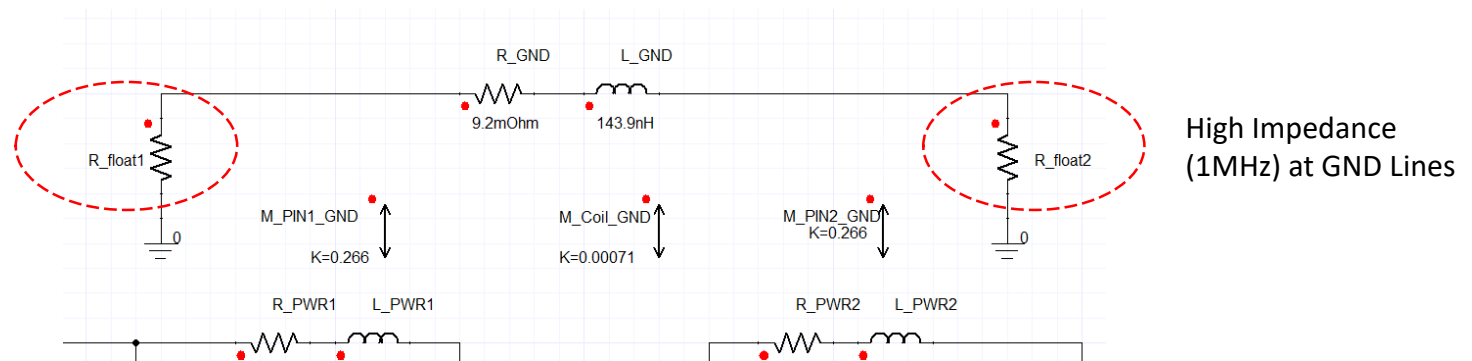
- Result ② : What happens if GND is floated

• → No current induced



Coil, PWR Line Current

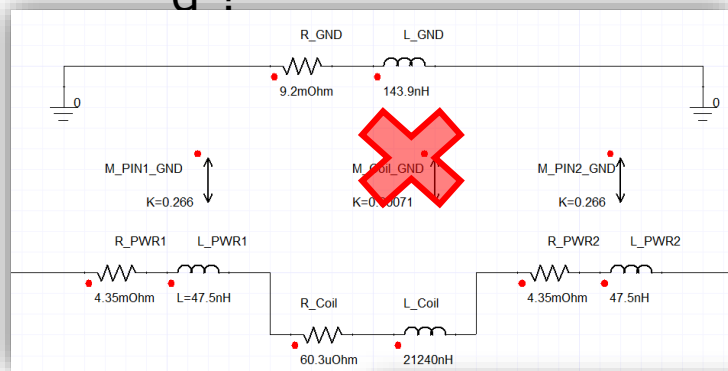
GND Line Current  
(Induced Noise)



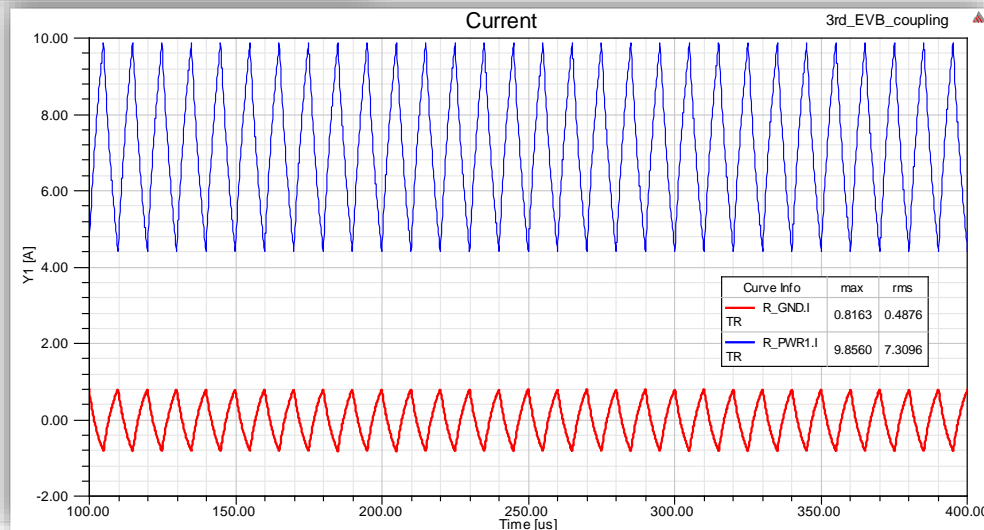
# Analysis : Circuit 2-1 Equivalent Circuit

## Simplorer

- Result ③ : What happens if M between Coil and GND is neglected?



Change in Inductive Noise



Coil, PWR Line Current

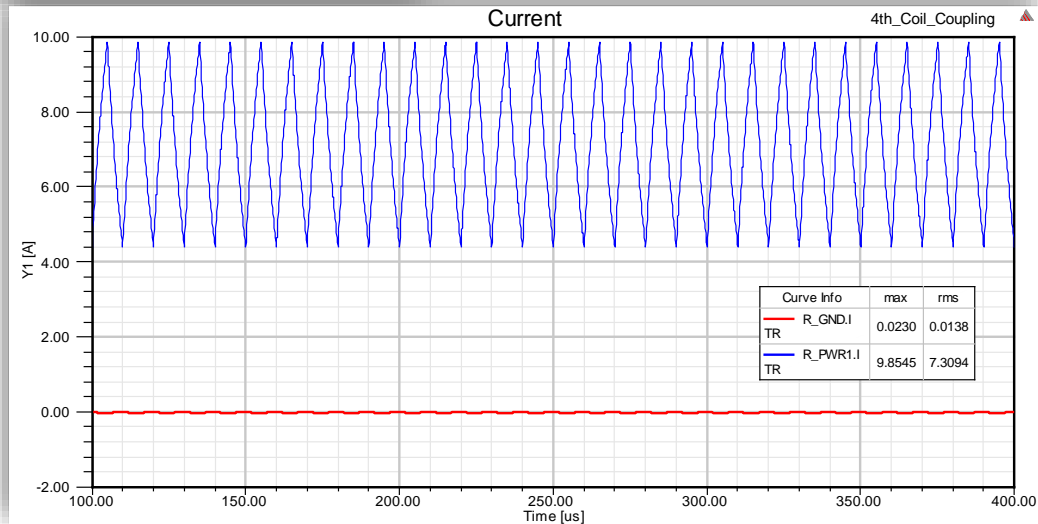
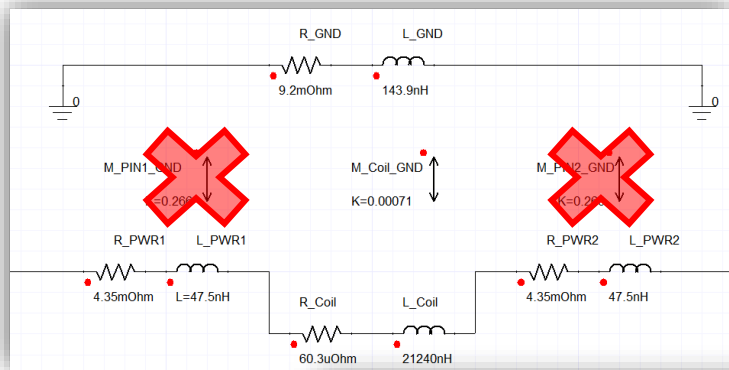
GND Line Current (Induced Noise)

# Analysis : Circuit 2-1 Equivalent Circuit

## Simplorer

Result ④ : What happens if M between (PIN\_1, PIN\_2) and GND is neglected ?

→ Inductive Noise significantly reduced



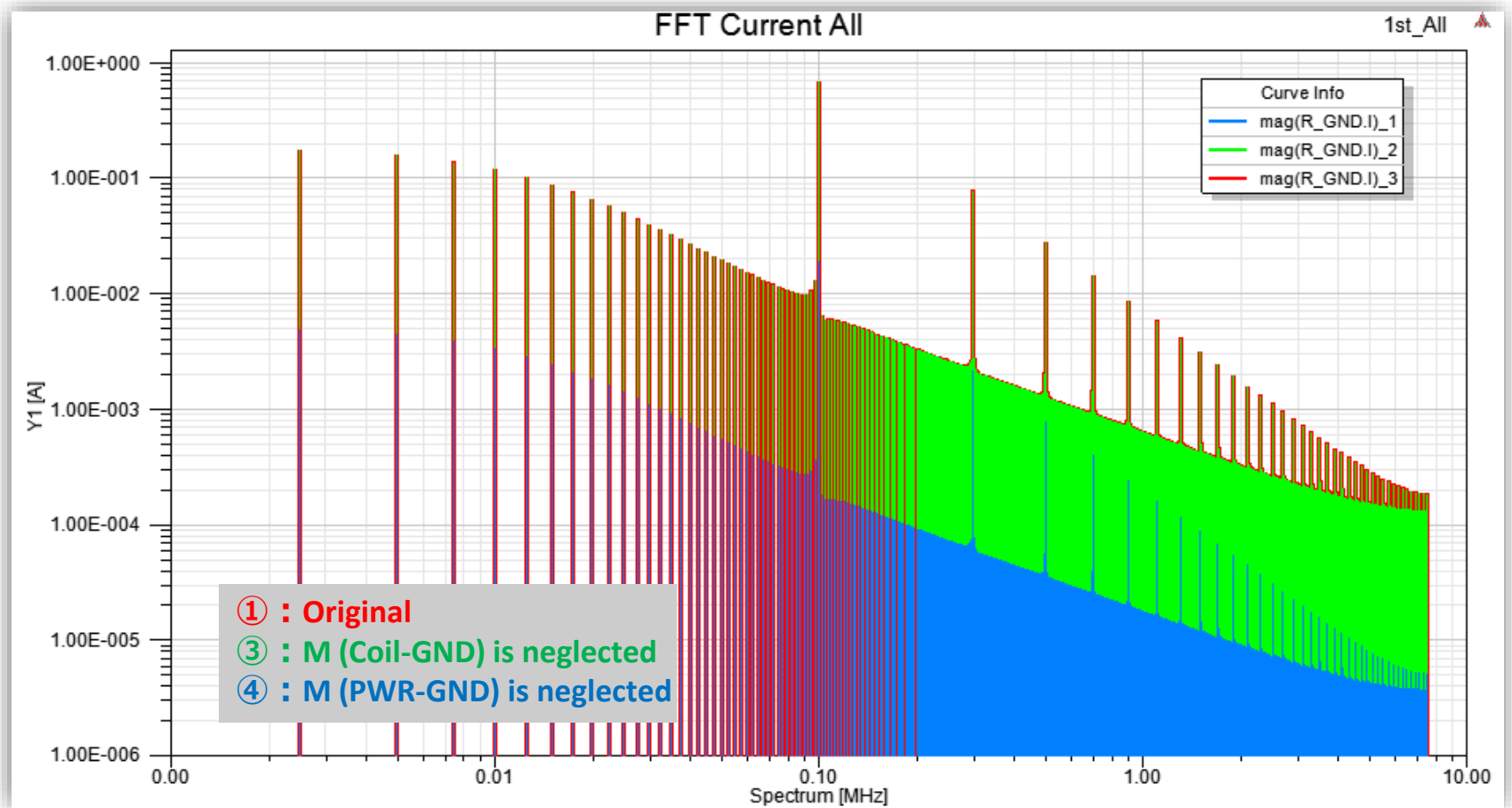
Coil, PWR Line Current

GND Line Current  
(Induced Noise)

# Analysis : Circuit 2-1 Equivalent Circuit

## Simplorer

- Result ①~④ : FFT on GND Line current

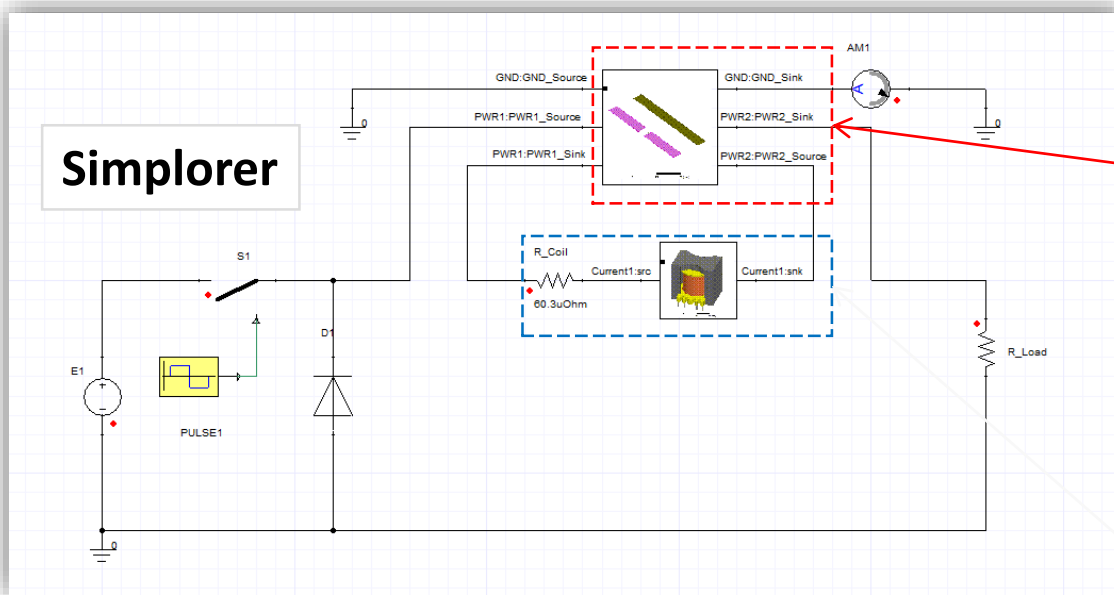


# Remarks

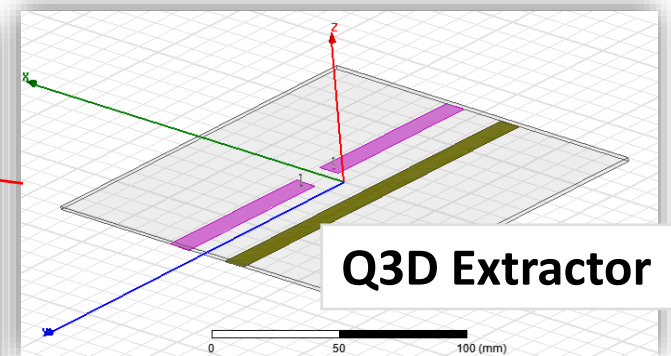
- \* Simulation can identify the dominant factor of the GND noise
- \* GND Line crosstalk noise is caused by the coupling between the traces.
- \* Coupling between the coil and the traces is negligibly small.
- \* **Suppression of Trace-to-Trace crosstalk must be more important than that of**
- **Trace-to-GND crosstalk.**

# Analysis : Circuit 2-2 EM-Circuit Coupling

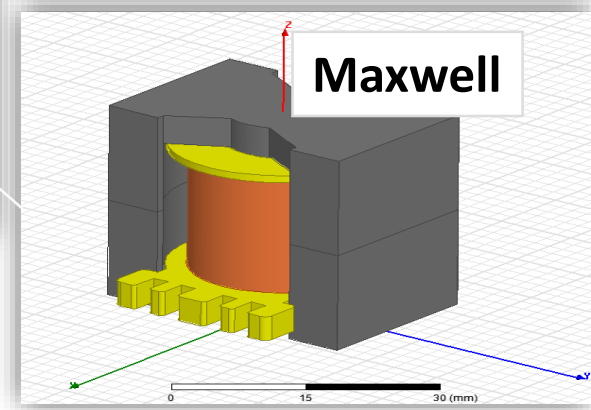
- Maxwell and Q3D models are imported into Simplorer
- Previous analysis confirmed the coupling between the Coil and the GND Line can be neglected



EM-Circuit Coupled Model



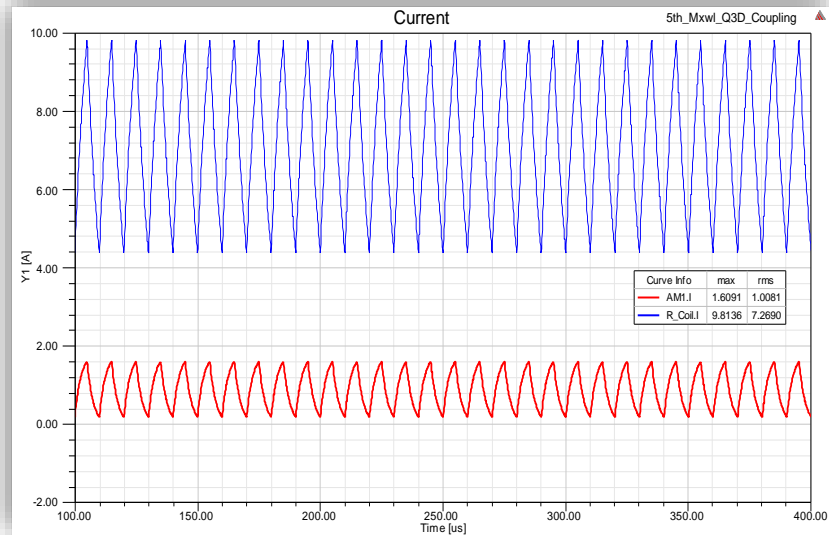
Q3D Extractor



Maxwell

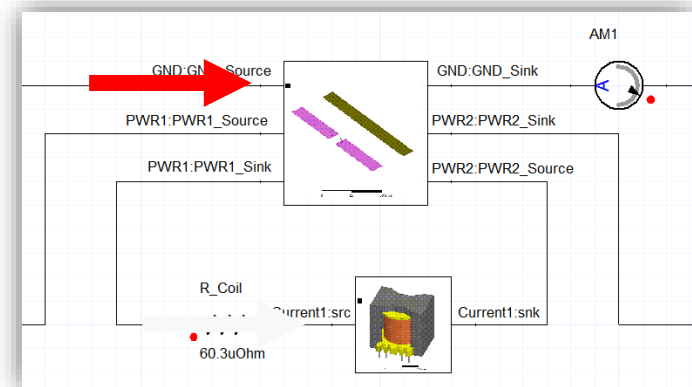
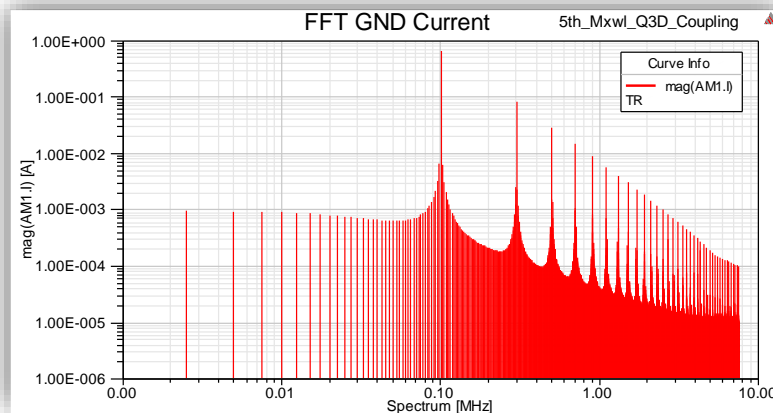
# Analysis : Circuit 2-2 EM-Circuit Coupling

- Result ①: Current in the Power Line and Induced current in the GND Line



Coil, PWR Line Current

GND Line Current  
(Induced Noise)



# Conclusions

- Effect of the leakage flux from the coil on the PCB traces is evaluated
  - by simulation
- Possible three factors of the noise source are investigated
- Noise due to the crosstalk coupling among the traces on the PCB is dominant, while crosstalk between the coil and the traces is negligible
- ANSYS can provide the effective noise evaluation solution by EM-Circuit coupled simulation

# Join the Simulation Conversation!

The ANSYS Blog is now live at [blog.ansys.com](http://blog.ansys.com).

Read. Comment. Join the Conversation!

The screenshot shows a web browser window displaying the ANSYS Blog homepage. The browser's address bar shows [blog.ansys.com](http://blog.ansys.com). The website header features the ANSYS logo and the tagline "Realize Your Product Promise™" above a graphic of gears and a target. A navigation menu includes links for ANSYS.com, Blogs, Industry, Product, Business Initiatives, and Tips & Tricks, along with a search bar. The main content area displays two blog posts. The first post, "A Cloud on the Horizon?", is dated October 3, 2011, by Robert Harwood and discusses the U.S. Air Force's move to cloud computing. The second post, "Using Surface and Edges for 3-D Modelling Operations in DesignModeler", is dated September 29, 2011, by Michael Tooley and discusses 3-D modelling operations. A categories sidebar on the right lists: Business Initiatives (5), Industry (5), Aerospace & Defense (2), Automotive (1), Oil & Gas (1), Product (2), and Tips & Tricks (3). The browser's taskbar at the bottom shows a file named "R14 Mesh Morpher ...pptx" and a "Show all downloads" button.